



PCU9956A

24-channel U^{Fm} 5 MHz I²C-bus 57 mA/20 V constant current LED driver

Rev. 1 — 24 January 2014

Product data sheet

1. General description

The PCU9956A is an Ultra Fast-mode (U^{Fm}) I²C-bus controlled 24-channel constant current LED driver optimized for dimming and blinking 57 mA Red/Green/Blue/Amber (RGBA) LEDs in amusement products. Each LED output has its own 8-bit resolution (256 steps) fixed frequency individual PWM controller that operates at 31.25 kHz with a duty cycle that is adjustable from 0 % to 99.6 % to allow the LED to be set to a specific brightness value. An additional 8-bit resolution (256 steps) group PWM controller has both a fixed frequency of 122 Hz and an adjustable frequency between 15 Hz to once every 16.8 seconds with a duty cycle that is adjustable from 0 % to 99.6 % that is used to either dim or blink all LEDs with the same value.

Each LED output can be off, on (no PWM control), set at its individual PWM controller value or at both individual and group PWM controller values. The PCU9956A operates with a supply voltage range of 3 V to 5.5 V and the constant current sink LED outputs allow up to 20 V for the LED supply. The output peak current is adjustable with an 8-bit linear DAC from 225 μ A to 57 mA.

A thermal shutdown feature protects the device when internal junction temperature exceeds the limit allowed for the process.

The PCU9956A device is the first LED controller device in a new Ultra Fast-mode (U^{Fm}) I²C-bus family. U^{Fm} I²C-bus devices offer higher frequency (up to 5 MHz). the U^{Fm} I²C-bus slave devices operate in receive-only mode. That is, only I²C writes to PCU9956A are supported. As such, there are no status registers in PCU9956A. The PCU9956A allows significantly higher data transfer rate compared to the Fast-mode Plus version (PCA9956A).

The active LOW output enable input pin (\overline{OE}) blinks all the LED outputs and can be used to externally PWM the outputs, which is useful when multiple devices need to be dimmed or blinked together without using software control.

Software programmable LED Group and three Sub Call I²C-bus addresses allow all or defined groups of PCU9956A devices to respond to a common I²C-bus address, allowing for example, all red LEDs to be turned on or off at the same time or marquee chasing effect, thus minimizing I²C-bus commands. On power-up, PCU9956A will have a unique Sub Call address to identify it as a 24-channel LED driver. This allows mixing of devices with different channel widths. Three hardware address pins on PCU9956A allow up to 125 devices on the same bus.



The Software Reset (SWRST) function allows the master to perform a reset of the PCU9956A through the I²C-bus, identical to the Power-On Reset (POR) that initializes the registers to their default state causing the output current switches to be OFF (LED off). This allows an easy and quick way to reconfigure all device registers to the same condition.

2. Features and benefits

- 24 LED drivers. Each output programmable at:
 - ◆ Off
 - ◆ On
 - ◆ Programmable LED brightness
 - ◆ Programmable group dimming/blinking mixed with individual LED brightness
 - ◆ Programmable LED output delay to reduce EMI and surge currents
- 24 constant current output channels can sink up to 57 mA, tolerate up to 20 V when OFF
- Output current adjusted through an external resistor (REXT input)
- Output current accuracy
 - ◆ ±4 % between output channels
 - ◆ ±6 % between PCU9956A devices
- Thermal shut-down for overtemperature
- 5 MHz Ultra Fast-mode I²C-bus interface
- 256-step (8-bit) linear programmable brightness per LED output varying from fully off (default) to maximum brightness using a 31.25 kHz PWM signal
- 256-step group brightness control allows general dimming (using a 122 Hz PWM signal) from fully off to maximum brightness (default)
- 256-step group blinking with frequency programmable from 15 Hz to 16.8 s and duty cycle from 0 % to 99.6 %
- Output state change programmable on the Acknowledge (bit 9, this bit is always set to 1 by I²C-bus master) or the STOP Command to update outputs byte-by-byte or all at the same time (default to 'Change on STOP').
- Active LOW Output Enable ($\overline{\text{OE}}$) input pin allows for hardware blinking and dimming of the LEDs
- Three quinary hardware address pins allow 125 PCU9956A devices to be connected to the same I²C-bus and to be individually programmed
- 4 software programmable I²C-bus addresses (one LED Group Call address and three LED Sub Call addresses) allow groups of devices to be addressed at the same time in any combination (for example, one register used for 'All Call' so that all the PCU9956As on the I²C-bus can be addressed at the same time and the second register used for three different addresses so that $\frac{1}{3}$ of all devices on the bus can be addressed at the same time in a group). Software enable and disable for each programmable I²C-bus address.
- Unique power-up default Sub Call address allows mixing of devices with different channel widths
- Software Reset feature (SWRST Call) allows the device to be reset through the I²C-bus
- 8 MHz internal oscillator requires no external components

- Internal power-on reset
- Noise filter on USDA/USCL inputs
- No glitch on LED outputs on power-up
- Low standby current
- Operating power supply voltage (V_{DD}) range of 3 V to 5.5 V
- 5.5 V tolerant inputs on non-LED pins
- -40 °C to +85 °C operation
- ESD protection exceeds 3000 V HBM per JESD22-A114
- Latch-up testing is done to JEDEC Standard JESD78 which exceeds 100 mA
- Packages offered: HTSSOP38

3. Applications

- Amusement products
- RGB or RGBA LED drivers
- LED status information
- LED displays
- LCD backlights
- Keypad backlights for cellular phones or handheld devices

4. Ordering information

Table 1. Ordering information

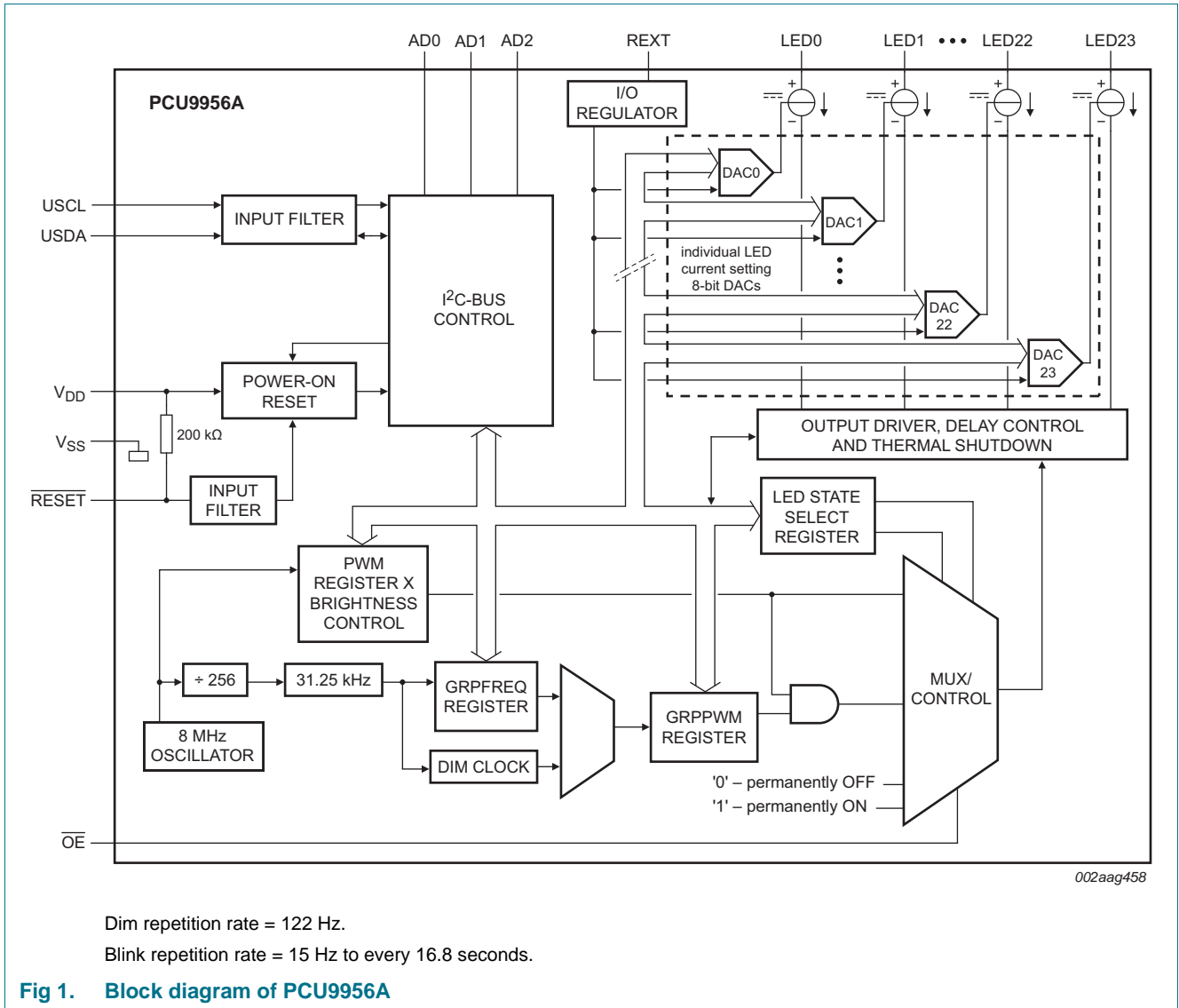
| Type number | Topside mark | Package | | |
|-------------|--------------|----------|---|-----------|
| | | Name | Description | Version |
| PCU9956ATW | PCU9956ATW | HTSSOP38 | plastic thermal enhanced thin shrink small outline package; 38 leads; body width 4.4 mm; lead pitch 0.5 mm; exposed die pad | SOT1331-1 |

4.1 Ordering options

Table 2. Ordering options

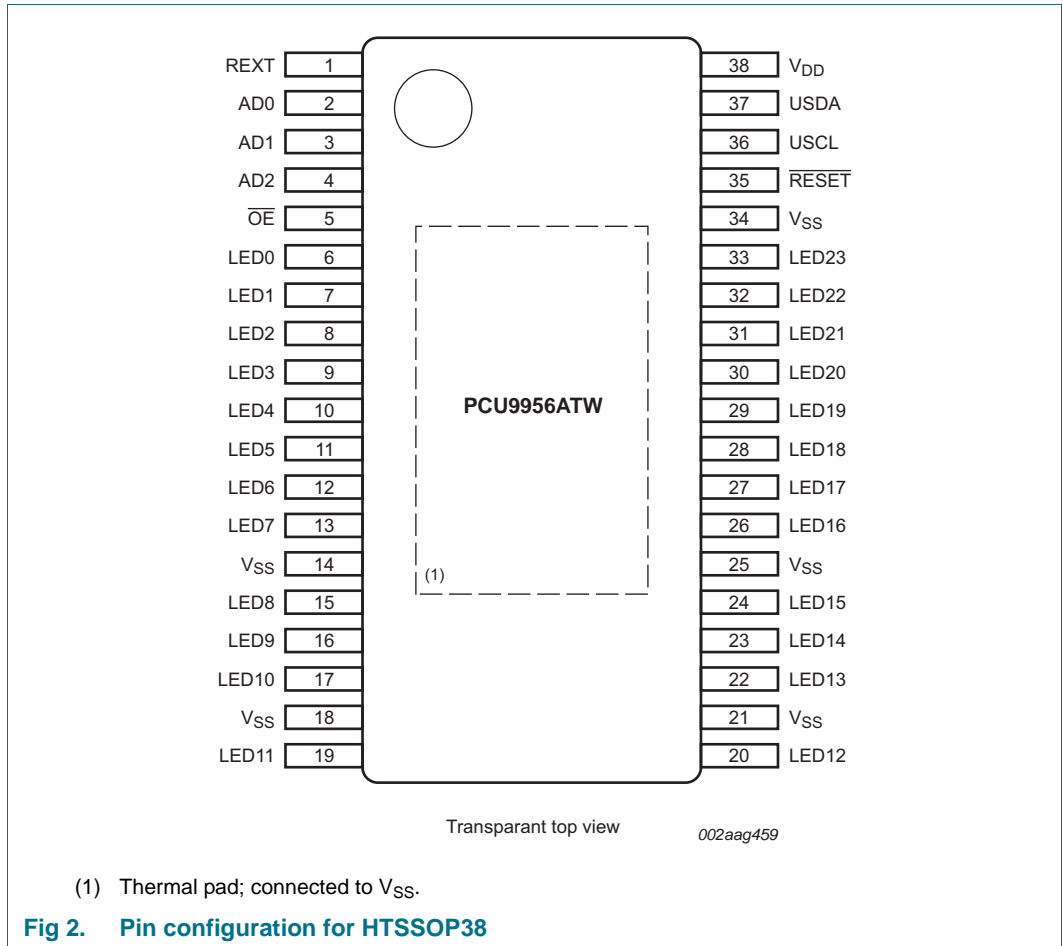
| Type number | Orderable part number | Package | Packing method | Minimum order quantity | Temperature |
|-------------|-----------------------|----------|---|------------------------|--|
| PCU9956ATW | PCU9956ATWY | HTSSOP38 | Reel 13" Q1/T1 *standard mark SMD dry pack | 2500 | $T_{amb} = -40\text{ °C to }+85\text{ °C}$ |

5. Block diagram



6. Pinning information

6.1 Pinning



6.2 Pin description

Table 3. Pin description

| Symbol | Pin | Type | Description |
|---------------------------|-----------------------------------|--------------|--|
| REXT | 1 | I | current set resistor input; resistor to ground |
| AD0 | 2 | I | address input 0 |
| AD1 | 3 | I | address input 1 |
| AD2 | 4 | I | address input 2 |
| $\overline{\text{OE}}$ | 5 | I | active LOW output enable for LEDs |
| LED0 | 6 | O | LED driver 0 |
| LED1 | 7 | O | LED driver 1 |
| LED2 | 8 | O | LED driver 2 |
| LED3 | 9 | O | LED driver 3 |
| LED4 | 10 | O | LED driver 4 |
| LED5 | 11 | O | LED driver 5 |
| LED6 | 12 | O | LED driver 6 |
| LED7 | 13 | O | LED driver 7 |
| LED8 | 15 | O | LED driver 8 |
| LED9 | 16 | O | LED driver 9 |
| LED10 | 17 | O | LED driver 10 |
| LED11 | 19 | O | LED driver 11 |
| LED12 | 20 | O | LED driver 12 |
| LED13 | 22 | O | LED driver 13 |
| LED14 | 23 | O | LED driver 14 |
| LED15 | 24 | O | LED driver 15 |
| LED16 | 26 | O | LED driver 16 |
| LED17 | 27 | O | LED driver 17 |
| LED18 | 28 | O | LED driver 18 |
| LED19 | 29 | O | LED driver 19 |
| LED20 | 30 | O | LED driver 20 |
| LED21 | 31 | O | LED driver 21 |
| LED22 | 32 | O | LED driver 22 |
| LED23 | 33 | O | LED driver 23 |
| $\overline{\text{RESET}}$ | 35 | I | active LOW reset input |
| USCL | 36 | I | U ^F m serial clock line |
| USDA | 37 | I | U ^F m serial data line |
| V _{SS} | 14, 18, 21, 25, 34 ^[1] | ground | supply ground |
| V _{DD} | 38 | power supply | supply voltage |

- [1] HTSSOP38 package supply ground is connected to both V_{SS} pins and exposed center pad. V_{SS} pins must be connected to supply ground for proper device operation. For enhanced thermal, electrical, and board level performance, the exposed pad needs to be soldered to the board using a corresponding thermal pad on the board and for proper heat conduction through the board, thermal vias need to be incorporated in the printed-circuit board in the thermal pad region.

7. Functional description

Refer to [Figure 1 “Block diagram of PCU9956A”](#).

7.1 Device addresses

Following a START condition, the bus master must output the address of the slave it is accessing.

For PCU9956A there are a maximum of 125 possible programmable addresses using the three quinary hardware address pins.

7.1.1 Regular I²C-bus slave address

The I²C-bus slave address of the PCU9956A is shown in [Figure 3](#). The 7-bit slave address is determined by the quinary input pads AD0, AD1 and AD2. Each pad can have one of five states (GND, pull-up, floating, pull-down, and V_{DD}) based on how the input pad is connected on the board. At power-up or hardware/software reset, the quinary input pads are sampled and set the slave address of the device internally. To conserve power, once the slave address is determined, the quinary input pads are turned off and will not be sampled until the next time the device is power cycled. [Table 4](#) lists the five possible connections for the quinary input pads along with the external resistor values that must be used.

Table 4. Quinary input pad connection

| Pad connection (pins AD2, AD1, AD0) ^[1] | Mnemonic | External resistor (kΩ) | |
|---|-----------------|------------------------|------|
| | | Min. | Max. |
| tie to ground | GND | 0 | 17.9 |
| resistor pull-down to ground | PD | 34.8 | 270 |
| open (floating) | FLT | 503 | ∞ |
| resistor pull-up to V _{DD} | PU | 31.7 | 340 |
| tie to V _{DD} | V _{DD} | 0 | 22.1 |

[1] These AD[2:0] inputs must be stable before the supply V_{DD} to chip.

[Table 5](#) lists all 125 possible slave addresses of the device based on all combinations of the five states connected to three address input pins AD0, AD1 and AD2.

Table 5. I²C-bus slave address

| Hardware selectable input pins | | | I ² C-bus slave address for PCU9956A | | | |
|--------------------------------|-----|-----------------|---|-----|------------------------|-------------------|
| AD2 | AD1 | AD0 | Decimal | Hex | Binary (A[6:0]) | Address (R/W = 0) |
| GND | GND | GND | 1 | 01 | 0000001 ^[1] | 02h |
| GND | GND | PD | 2 | 02 | 0000010 ^[1] | 04h |
| GND | GND | FLT | 3 | 03 | 0000011 ^[1] | 06h |
| GND | GND | PU | 4 | 04 | 0000100 ^[1] | 08h |
| GND | GND | V _{DD} | 5 | 05 | 0000101 ^[1] | 0Ah |
| GND | PD | GND | 6 | 06 | 0000110 ^[1] | 0Ch |
| GND | PD | PD | 7 | 07 | 0000111 ^[1] | 0Eh |
| GND | PD | FLT | 8 | 08 | 0001000 | 10h |
| GND | PD | PU | 9 | 09 | 0001001 | 12h |

Table 5. I²C-bus slave address ...continued

| Hardware selectable input pins | | | I ² C-bus slave address for PCU9956A | | | |
|--------------------------------|-----------------|-----------------|---|-----|-----------------|-------------------|
| AD2 | AD1 | AD0 | Decimal | Hex | Binary (A[6:0]) | Address (R/W = 0) |
| GND | PD | V _{DD} | 10 | 0A | 0001010 | 14h |
| GND | FLT | GND | 11 | 0B | 0001011 | 16h |
| GND | FLT | PD | 12 | 0C | 0001100 | 18h |
| GND | FLT | FLT | 13 | 0D | 0001101 | 1Ah |
| GND | FLT | PU | 14 | 0E | 0001110 | 1Ch |
| GND | FLT | V _{DD} | 15 | 0F | 0001111 | 1Eh |
| GND | PU | GND | 16 | 10 | 0010000 | 20h |
| GND | PU | PD | 17 | 11 | 0010001 | 22h |
| GND | PU | FLT | 18 | 12 | 0010010 | 24h |
| GND | PU | PU | 19 | 13 | 0010011 | 26h |
| GND | PU | V _{DD} | 20 | 14 | 0010100 | 28h |
| GND | V _{DD} | GND | 21 | 15 | 0010101 | 2Ah |
| GND | V _{DD} | PD | 22 | 16 | 0010110 | 2Ch |
| GND | V _{DD} | FLT | 23 | 17 | 0010111 | 2Eh |
| GND | V _{DD} | PU | 24 | 18 | 0011000 | 30h |
| GND | V _{DD} | V _{DD} | 25 | 19 | 0011001 | 32h |
| PD | GND | GND | 26 | 1A | 0011010 | 34h |
| PD | GND | PD | 27 | 1B | 0011011 | 36h |
| PD | GND | FLT | 28 | 1C | 0011100 | 38h |
| PD | GND | PU | 29 | 1D | 0011101 | 3Ah |
| PD | GND | V _{DD} | 30 | 1E | 0011110 | 3Ch |
| PD | PD | GND | 31 | 1F | 0011111 | 3Eh |
| PD | PD | PD | 32 | 20 | 0100000 | 40h |
| PD | PD | FLT | 33 | 21 | 0100001 | 42h |
| PD | PD | PU | 34 | 22 | 0100010 | 44h |
| PD | PD | V _{DD} | 35 | 23 | 0100011 | 46h |
| PD | FLT | GND | 36 | 24 | 0100100 | 48h |
| PD | FLT | PD | 37 | 25 | 0100101 | 4Ah |
| PD | FLT | FLT | 38 | 26 | 0100110 | 4Ch |
| PD | FLT | PU | 39 | 27 | 0100111 | 4Eh |
| PD | FLT | V _{DD} | 40 | 28 | 0101000 | 50h |
| PD | PU | GND | 41 | 29 | 0101001 | 52h |
| PD | PU | PD | 42 | 2A | 0101010 | 54h |
| PD | PU | FLT | 43 | 2B | 0101011 | 56h |
| PD | PU | PU | 44 | 2C | 0101100 | 58h |
| PD | PU | V _{DD} | 45 | 2D | 0101101 | 5Ah |

Table 5. I²C-bus slave address ...continued

| Hardware selectable input pins | | | I ² C-bus slave address for PCU9956A | | | |
|--------------------------------|-----------------|-----------------|---|-----|-----------------|-------------------|
| AD2 | AD1 | AD0 | Decimal | Hex | Binary (A[6:0]) | Address (R/W = 0) |
| PD | V _{DD} | GND | 46 | 2E | 0101110 | 5Ch |
| PD | V _{DD} | PD | 47 | 2F | 0101111 | 5Eh |
| PD | V _{DD} | FLT | 48 | 30 | 0110000 | 60h |
| PD | V _{DD} | PU | 49 | 31 | 0110001 | 62h |
| PD | V _{DD} | V _{DD} | 50 | 32 | 0110010 | 64h |
| FLT | GND | GND | 51 | 33 | 0110011 | 66h |
| FLT | GND | PD | 52 | 34 | 0110100 | 68h |
| FLT | GND | FLT | 53 | 35 | 0110101 | 6Ah |
| FLT | GND | PU | 54 | 36 | 0110110 | 6Ch |
| FLT | GND | V _{DD} | 55 | 37 | 0110111 | 6Eh |
| FLT | PD | GND | 56 | 38 | 0111000 | 70h |
| FLT | PD | PD | 57 | 39 | 0111001 | 72h |
| FLT | PD | FLT | 58 | 3A | 0111010 | 74h |
| FLT | PD | PU | 59 | 3B | 0111011 | 76h |
| FLT | PD | V _{DD} | 60 | 3C | 0111100 | 78h |
| FLT | FLT | GND | 61 | 3D | 0111101 | 7Ah |
| FLT | FLT | PD | 62 | 3E | 0111110 | 7Ch |
| FLT | FLT | FLT | 63 | 3F | 0111111 | 7Eh |
| FLT | FLT | PU | 64 | 40 | 1000000 | 80h |
| FLT | FLT | V _{DD} | 65 | 41 | 1000001 | 82h |
| FLT | PU | GND | 66 | 42 | 1000010 | 84h |
| FLT | PU | PD | 67 | 43 | 1000011 | 86h |
| FLT | PU | FLT | 68 | 44 | 1000100 | 88h |
| FLT | PU | PU | 69 | 45 | 1000101 | 8Ah |
| FLT | PU | V _{DD} | 70 | 46 | 1000110 | 8Ch |
| FLT | V _{DD} | GND | 71 | 47 | 1000111 | 8Eh |
| FLT | V _{DD} | PD | 72 | 48 | 1001000 | 90h |
| FLT | V _{DD} | FLT | 73 | 49 | 1001001 | 92h |
| FLT | V _{DD} | PU | 74 | 4A | 1001010 | 94h |
| FLT | V _{DD} | V _{DD} | 75 | 4B | 1001011 | 96h |
| PU | GND | GND | 76 | 4C | 1001100 | 98h |
| PU | GND | PD | 77 | 4D | 1001101 | 9Ah |
| PU | GND | FLT | 78 | 4E | 1001110 | 9Ch |
| PU | GND | PU | 79 | 4F | 1001111 | 9Eh |
| PU | GND | V _{DD} | 80 | 50 | 1010000 | A0h |

Table 5. I²C-bus slave address ...continued

| Hardware selectable input pins | | | I ² C-bus slave address for PCU9956A | | | |
|--------------------------------|-----------------|-----------------|---|-----|------------------------|-------------------|
| AD2 | AD1 | AD0 | Decimal | Hex | Binary (A[6:0]) | Address (R/W = 0) |
| PU | PD | GND | 81 | 51 | 1010001 | A2h |
| PU | PD | PD | 82 | 52 | 1010010 | A4h |
| PU | PD | FLT | 83 | 53 | 1010011 | A6h |
| PU | PD | PU | 84 | 54 | 1010100 | A8h |
| PU | PD | V _{DD} | 85 | 55 | 1010101 | AAh |
| PU | FLT | GND | 86 | 56 | 1010110 | ACh |
| PU | FLT | PD | 87 | 57 | 1010111 | AEnh |
| PU | FLT | FLT | 88 | 58 | 1011000 | B0h |
| PU | FLT | PU | 89 | 59 | 1011001 | B2h |
| PU | FLT | V _{DD} | 90 | 5A | 1011010 | B4h |
| PU | PU | GND | 91 | 5B | 1011011 | B6h |
| PU | PU | PD | 92 | 5C | 1011100 | B8h |
| PU | PU | FLT | 93 | 5D | 1011101 | BAh |
| PU | PU | PU | 94 | 5E | 1011110 | BCh |
| PU | PU | V _{DD} | 95 | 5F | 1011111 | BEh |
| PU | V _{DD} | GND | 96 | 60 | 1100000 | C0h |
| PU | V _{DD} | PD | 97 | 61 | 1100001 | C2h |
| PU | V _{DD} | FLT | 98 | 62 | 1100010 | C4h |
| PU | V _{DD} | PU | 99 | 63 | 1100011 | C6h |
| PU | V _{DD} | V _{DD} | 100 | 64 | 1100100 | C8h |
| V _{DD} | GND | GND | 101 | 65 | 1100101 | CAh |
| V _{DD} | GND | PD | 102 | 66 | 1100110 | CCh |
| V _{DD} | GND | FLT | 103 | 67 | 1100111 | CEh |
| V _{DD} | GND | PU | 104 | 68 | 1101000 | D0h |
| V _{DD} | GND | V _{DD} | 105 | 69 | 1101001 | D2h |
| V _{DD} | PD | GND | 106 | 6A | 1101010 | D4h |
| V _{DD} | PD | PD | 107 | 6B | 1101011 | D6h |
| V _{DD} | PD | FLT | 108 | 6C | 1101100 | D8h |
| V _{DD} | PD | PU | 109 | 6D | 1101101 | DAh |
| V _{DD} | PD | V _{DD} | 110 | 6E | 1101110 | DCh |
| V _{DD} | FLT | GND | 111 | 6F | 1101111 | DEh |
| V _{DD} | FLT | PD | 112 | 70 | 1110000 | E0h |
| V _{DD} | FLT | FLT | 113 | 71 | 1110001 | E2h |
| V _{DD} | FLT | PU | 114 | 72 | 1110010 | E4h |
| V _{DD} | FLT | V _{DD} | 115 | 73 | 1110011 | E6h |
| V _{DD} | PU | GND | 116 | 74 | 1110100 | E8h |
| V _{DD} | PU | PD | 117 | 75 | 1110101 | EAh |
| V _{DD} | PU | FLT | 118 | 76 | 1110110 | ECh |
| V _{DD} | PU | PU | 119 | 77 | 1110111 | EEh |
| V _{DD} | PU | V _{DD} | 120 | 78 | 1111000 ^[1] | F0h |

Table 5. I²C-bus slave address ...continued

| Hardware selectable input pins | | | I ² C-bus slave address for PCU9956A | | | |
|--------------------------------|-----------------|-----------------|---|-----|------------------------|-------------------|
| AD2 | AD1 | AD0 | Decimal | Hex | Binary (A[6:0]) | Address (R/W = 0) |
| V _{DD} | V _{DD} | GND | 121 | 79 | 1111001 ^[1] | F2h |
| V _{DD} | V _{DD} | PD | 122 | 7A | 1111010 ^[1] | F4h |
| V _{DD} | V _{DD} | FLT | 123 | 7B | 1111011 ^[1] | F6h |
| V _{DD} | V _{DD} | PU | 124 | 7C | 1111100 ^[1] | F8h |
| V _{DD} | V _{DD} | V _{DD} | 125 | 7D | 1111101 ^[1] | FAh |

[1] See 'Remark' below.

Remark: Reserved I²C-bus addresses must be used with caution since they can interfere with:

- 'reserved for future use' I²C-bus addresses (0000 011, 1111 1XX)
- slave devices that use the 10-bit addressing scheme (1111 0XX)
- slave devices that are designed to respond to the General Call address (0000 000)
- High-speed mode (Hs-mode) master code (0000 1XX)

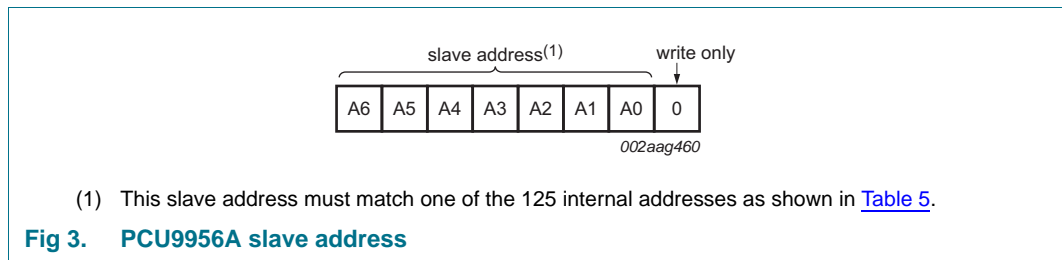


Fig 3. PCU9956A slave address

The last bit of the address byte defines the operation to be performed. Only writes to PCU9956A are supported, therefore the last bit is set to 0. No Read available with U^Fm I²C-bus.

7.1.2 LED All Call I²C-bus address

- Default power-up value (ALLCALLADR register): E0h or 1110 000X
- Programmable through I²C-bus (volatile programming)
- At power-up, LED All Call I²C-bus address is enabled.

See [Section 7.3.10 "ALLCALLADR, LED All Call I²C-bus address"](#) for more detail.

Remark: The default LED All Call I²C-bus address (E0h or 1110 000X) must not be used as a regular I²C-bus slave address since this address is enabled at power-up. All of the PCU9956As on the I²C-bus will recognize the address if sent by the I²C-bus master.

7.1.3 LED Sub Call I²C-bus addresses

- 3 different I²C-bus addresses can be used
- Default power-up values:
 - SUBADR1 register: EEh or 1110 111X
 - SUBADR2 register: EEh or 1110 111X
 - SUBADR3 register: EEh or 1110 111X
- Programmable through I²C-bus (volatile programming)
- At power-up, SUBADR1 is enabled while SUBADR2 and SUBADR3 I²C-bus addresses are disabled.

Remark: At power-up SUBADR1 identifies this device as a 24-channel driver.

See [Section 7.3.9 “LED Sub Call I²C-bus addresses for PCU9956A”](#) for more detail.

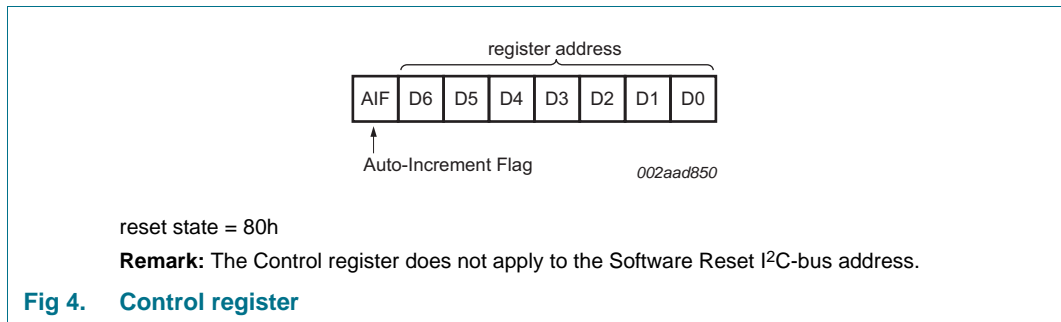
Remark: The default LED Sub Call I²C-bus addresses may be used as regular I²C-bus slave addresses as long as they are disabled.

7.2 Control register

Following the slave address, LED All Call address or LED Sub Call address, the bus master will send a byte to the PCU9956A, which will be stored in the Control register.

The lowest 7 bits are used as a pointer to determine which register will be accessed (D[6:0]). The highest bit is used as Auto-Increment Flag (AIF).

This bit along with the MODE1 register bit 5 and bit 6 provide the Auto-Increment feature.



When the Auto-Increment Flag is set (AIF = logic 1), the seven low order bits of the Control register are automatically incremented after a write. This allows the user to program the registers sequentially. Four different types of Auto-Increment are possible, depending on AI1 and AI0 values of MODE1 register.

Table 6. Auto-Increment options

| AIF | AI1 ^[1] | AI0 ^[1] | Function |
|-----|--------------------|--------------------|--|
| 0 | 0 | 0 | no Auto-Increment |
| 1 | 0 | 0 | Auto-Increment for registers (00h to 3Eh). D[6:0] roll over to 00h after the last register 3Eh is accessed. |
| 1 | 0 | 1 | Auto-Increment for individual brightness registers only (0Ah to 21h). D[6:0] roll over to 0Ah after the last register (21h) is accessed. |
| 1 | 1 | 0 | Auto-Increment for MODE1 to IREF23 control registers (00h to 39h). D[6:0] roll over to 00h after the last register (39h) is accessed. |
| 1 | 1 | 1 | Auto-Increment for global control registers and individual brightness registers (08h to 21h). D[6:0] roll over to 08h after the last register (21h) is accessed. |

[1] AI1 and AI0 come from MODE1 register.

Remark: Other combinations not shown in [Table 6](#) (AIF + AI[1:0] = 001b, 010b and 011b) are reserved and must not be used for proper device operation.

AIF + AI[1:0] = 000b is used when the same register must be accessed several times during a single I²C-bus communication, for example, changes the brightness of a single LED. Data is overwritten each time the register is accessed during a write operation.

AIF + AI[1:0] = 100b is used when all the registers must be sequentially accessed, for example, power-up programming.

AIF + AI[1:0] = 101b is used when the 24 LED drivers must be individually programmed with different values during the same I²C-bus communication, for example, changing color setting to another color setting.

AIF + AI[1:0] = 110b is used when MODE1 to IREF23 registers must be programmed with different settings during the same I²C-bus communication.

AIF + AI[1:0] = 111b is used when the 24 LED drivers must be individually programmed with different values in addition to global programming.

Only the 7 least significant bits D[6:0] are affected by the AIF, AI1 and AI0 bits.

When the Control register is written, the register entry point determined by D[6:0] is the first register that will be addressed (write operation), and can be anywhere between 00h and 3Eh (as defined in [Table 7](#)). When AIF = 1, the Auto-Increment Flag is set and the rollover value at which the register increment stops and goes to the next one is determined by AIF, AI1 and AI0. See [Table 6](#) for rollover values. For example, if MODE1 register bit AI1 = 0 and AI0 = 1 and if the Control register = 1001 0000, then the register addressing sequence will be (in hex):

10 → 11 → ... → 21 → 0A → 0B → ... → 21 → 0A → 0B → ... as long as the master keeps sending data.

If MODE1 register bit AI1 = 0 and AI0 = 0 and if the Control register = 1010 0010, then the register addressing sequence will be (in hex):

22 → 23 → ... → 3E → 00 → 01 → ... → 21 → 0A → 0B → ... as long as the master keeps sending data.

If MODE1 register bit AI1 = 0 and AI0 = 1 and if the Control register = 1000 0101, then the register addressing sequence will be (in hex):

05 → 06 → ... → 21 → 0A → 0B → ... → 21 → 0A → 0B → ... as long as the master keeps sending data.

Remark: Writing to registers marked 'not used' will be ignored.

7.3 Register definitions

Table 7. Register summary

| Register number (hex) | D6 | D5 | D4 | D3 | D2 | D1 | D0 | Name | Type | Function |
|-----------------------|----|----|----|----|----|----|----|---------|------------|--------------------------|
| 00h | 0 | 0 | 0 | 0 | 0 | 0 | 0 | MODE1 | write only | Mode register 1 |
| 01h | 0 | 0 | 0 | 0 | 0 | 0 | 1 | MODE2 | write only | Mode register 2 |
| 02h | 0 | 0 | 0 | 0 | 0 | 1 | 0 | LEDOUT0 | write only | LED output state 0 |
| 03h | 0 | 0 | 0 | 0 | 0 | 1 | 1 | LEDOUT1 | write only | LED output state 1 |
| 04h | 0 | 0 | 0 | 0 | 1 | 0 | 0 | LEDOUT2 | write only | LED output state 2 |
| 05h | 0 | 0 | 0 | 0 | 1 | 0 | 1 | LEDOUT3 | write only | LED output state 3 |
| 06h | 0 | 0 | 0 | 0 | 1 | 1 | 0 | LEDOUT4 | write only | LED output state 4 |
| 07h | 0 | 0 | 0 | 0 | 1 | 1 | 1 | LEDOUT5 | write only | LED output state 5 |
| 08h | 0 | 0 | 0 | 1 | 0 | 0 | 0 | GRPPWM | write only | group duty cycle control |
| 09h | 0 | 0 | 0 | 1 | 0 | 0 | 1 | GRPFREQ | write only | group frequency |
| 0Ah | 0 | 0 | 0 | 1 | 0 | 1 | 0 | PWM0 | write only | brightness control LED0 |
| 0Bh | 0 | 0 | 0 | 1 | 0 | 1 | 1 | PWM1 | write only | brightness control LED1 |
| 0Ch | 0 | 0 | 0 | 1 | 1 | 0 | 0 | PWM2 | write only | brightness control LED2 |
| 0Dh | 0 | 0 | 0 | 1 | 1 | 0 | 1 | PWM3 | write only | brightness control LED3 |
| 0Eh | 0 | 0 | 0 | 1 | 1 | 1 | 0 | PWM4 | write only | brightness control LED4 |
| 0Fh | 0 | 0 | 0 | 1 | 1 | 1 | 1 | PWM5 | write only | brightness control LED5 |
| 10h | 0 | 0 | 1 | 0 | 0 | 0 | 0 | PWM6 | write only | brightness control LED6 |
| 11h | 0 | 0 | 1 | 0 | 0 | 0 | 1 | PWM7 | write only | brightness control LED7 |
| 12h | 0 | 0 | 1 | 0 | 0 | 1 | 0 | PWM8 | write only | brightness control LED8 |
| 13h | 0 | 0 | 1 | 0 | 0 | 1 | 1 | PWM9 | write only | brightness control LED9 |
| 14h | 0 | 0 | 1 | 0 | 1 | 0 | 0 | PWM10 | write only | brightness control LED10 |
| 15h | 0 | 0 | 1 | 0 | 1 | 0 | 1 | PWM11 | write only | brightness control LED11 |
| 16h | 0 | 0 | 1 | 0 | 1 | 1 | 0 | PWM12 | write only | brightness control LED12 |
| 17h | 0 | 0 | 1 | 0 | 1 | 1 | 1 | PWM13 | write only | brightness control LED13 |
| 18h | 0 | 0 | 1 | 1 | 0 | 0 | 0 | PWM14 | write only | brightness control LED14 |
| 19h | 0 | 0 | 1 | 1 | 0 | 0 | 1 | PWM15 | write only | brightness control LED15 |
| 1Ah | 0 | 0 | 1 | 1 | 0 | 1 | 0 | PWM16 | write only | brightness control LED16 |
| 1Bh | 0 | 0 | 1 | 1 | 0 | 1 | 1 | PWM17 | write only | brightness control LED17 |
| 1Ch | 0 | 0 | 1 | 1 | 1 | 0 | 0 | PWM18 | write only | brightness control LED18 |
| 1Dh | 0 | 0 | 1 | 1 | 1 | 0 | 1 | PWM19 | write only | brightness control LED19 |
| 1Eh | 0 | 0 | 1 | 1 | 1 | 1 | 0 | PWM20 | write only | brightness control LED20 |
| 1Fh | 0 | 0 | 1 | 1 | 1 | 1 | 1 | PWM21 | write only | brightness control LED21 |

Table 7. Register summary ...continued

| Register number (hex) | D6 | D5 | D4 | D3 | D2 | D1 | D0 | Name | Type | Function |
|-----------------------|----|----|----|----|----|----|----|------------|------------|---|
| 20h | 0 | 1 | 1 | 0 | 0 | 0 | 0 | PWM22 | write only | brightness control LED22 |
| 21h | 0 | 1 | 1 | 0 | 0 | 0 | 1 | PWM23 | write only | brightness control LED23 |
| 22h | 0 | 1 | 0 | 0 | 0 | 1 | 0 | IREF0 | write only | output gain control register 0 |
| 23h | 0 | 1 | 0 | 0 | 0 | 1 | 1 | IREF1 | write only | output gain control register 1 |
| 24h | 0 | 1 | 0 | 0 | 1 | 0 | 0 | IREF2 | write only | output gain control register 2 |
| 25h | 0 | 1 | 0 | 0 | 1 | 0 | 1 | IREF3 | write only | output gain control register 3 |
| 26h | 0 | 1 | 0 | 0 | 1 | 1 | 0 | IREF4 | write only | output gain control register 4 |
| 27h | 0 | 1 | 0 | 0 | 1 | 1 | 1 | IREF5 | write only | output gain control register 5 |
| 28h | 0 | 1 | 0 | 1 | 0 | 0 | 0 | IREF6 | write only | output gain control register 6 |
| 29h | 0 | 1 | 0 | 1 | 0 | 0 | 1 | IREF7 | write only | output gain control register 7 |
| 2Ah | 0 | 1 | 0 | 1 | 0 | 1 | 0 | IREF8 | write only | output gain control register 8 |
| 2Bh | 0 | 1 | 0 | 1 | 0 | 1 | 1 | IREF9 | write only | output gain control register 9 |
| 2Ch | 0 | 1 | 0 | 1 | 1 | 0 | 0 | IREF10 | write only | output gain control register 10 |
| 2Dh | 0 | 1 | 0 | 1 | 1 | 0 | 1 | IREF11 | write only | output gain control register 11 |
| 2Eh | 0 | 1 | 0 | 1 | 1 | 1 | 0 | IREF12 | write only | output gain control register 12 |
| 2Fh | 0 | 1 | 0 | 1 | 1 | 1 | 1 | IREF13 | write only | output gain control register 13 |
| 30h | 0 | 1 | 1 | 0 | 0 | 0 | 0 | IREF14 | write only | output gain control register 14 |
| 31h | 0 | 1 | 1 | 0 | 0 | 0 | 1 | IREF15 | write only | output gain control register 15 |
| 32h | 0 | 1 | 1 | 0 | 0 | 1 | 0 | IREF16 | write only | output gain control register 16 |
| 33h | 0 | 1 | 1 | 0 | 0 | 1 | 1 | IREF17 | write only | output gain control register 17 |
| 34h | 0 | 1 | 1 | 0 | 1 | 0 | 0 | IREF18 | write only | output gain control register 18 |
| 35h | 0 | 1 | 1 | 0 | 1 | 0 | 1 | IREF19 | write only | output gain control register 19 |
| 36h | 0 | 1 | 1 | 0 | 1 | 1 | 0 | IREF20 | write only | output gain control register 20 |
| 37h | 0 | 1 | 1 | 0 | 1 | 1 | 1 | IREF21 | write only | output gain control register 21 |
| 38h | 0 | 1 | 1 | 1 | 0 | 0 | 0 | IREF22 | write only | output gain control register 22 |
| 39h | 0 | 1 | 1 | 1 | 0 | 0 | 1 | IREF23 | write only | output gain control register 23 |
| 3Ah | 0 | 1 | 1 | 1 | 0 | 1 | 0 | OFFSET | write only | Offset/delay on LEDn outputs |
| 3Bh | 0 | 1 | 1 | 1 | 0 | 1 | 1 | SUBADR1 | write only | I ² C-bus subaddress 1 |
| 3Ch | 0 | 1 | 1 | 1 | 1 | 0 | 0 | SUBADR2 | write only | I ² C-bus subaddress 2 |
| 3Dh | 0 | 1 | 1 | 1 | 1 | 0 | 1 | SUBADR3 | write only | I ² C-bus subaddress 3 |
| 3Eh | 0 | 1 | 1 | 1 | 1 | 1 | 0 | ALLCALLADR | write only | All Call I ² C-bus address |
| 3Fh | 0 | 1 | 1 | 1 | 1 | 1 | 1 | PWMALL | write only | brightness control for all LEDn |
| 40h | 1 | 0 | 0 | 0 | 0 | 0 | 0 | IREFALL | write only | output gain control for all registers IREF0 to IREF23 |
| 41h to 7Fh | - | - | - | - | - | - | - | reserved | write only | not used ^[1] |

[1] Writing to registers marked 'not used' will be ignored.

7.3.1 MODE1 — Mode register 1

Table 8. MODE1 - Mode register 1 (address 00h) bit description

Legend: * default value.

| Bit | Symbol | Access | Value | Description |
|-----|---------|------------|-------|--|
| 7 | AIF | write only | 0 | Register Auto-Increment disabled. |
| | | | 1* | Register Auto-Increment enabled (write default logic 1). |
| 6 | AI1 | write only | 0* | Auto-Increment bit 1 = 0. Auto-increment range as defined in Table 6 . |
| | | | 1 | Auto-Increment bit 1 = 1. Auto-increment range as defined in Table 6 . |
| 5 | AI0 | write only | 0* | Auto-Increment bit 0 = 0. Auto-increment range as defined in Table 6 . |
| | | | 1 | Auto-Increment bit 0 = 1. Auto-increment range as defined in Table 6 . |
| 4 | SLEEP | write only | 0* | Normal mode ^[1] . |
| | | | 1 | Low power mode. Oscillator off ^[2] . |
| 3 | SUB1 | write only | 0 | PCU9956A does not respond to I ² C-bus subaddress 1. |
| | | | 1* | PCU9956A responds to I ² C-bus subaddress 1. |
| 2 | SUB2 | write only | 0* | PCU9956A does not respond to I ² C-bus subaddress 2. |
| | | | 1 | PCU9956A responds to I ² C-bus subaddress 2. |
| 1 | SUB3 | write only | 0* | PCU9956A does not respond to I ² C-bus subaddress 3. |
| | | | 1 | PCU9956A responds to I ² C-bus subaddress 3. |
| 0 | ALLCALL | write only | 0 | PCU9956A does not respond to LED All Call I ² C-bus address. |
| | | | 1* | PCU9956A responds to LED All Call I ² C-bus address. |

[1] It takes 500 μ s max. for the oscillator to be up and running once SLEEP bit has been set to logic 0. Timings on LED_n outputs are not guaranteed if PWM_x, GRPPWM or GRPFREQ registers are accessed within the 500 μ s window.

[2] No blinking or dimming is possible when the oscillator is off.

7.3.2 MODE2 — Mode register 2

Table 9. MODE2 - Mode register 2 (address 01h) bit description

Legend: * default value.

| Bit | Symbol | Access | Value | Description |
|-----|--------|------------|-------|---|
| 7 | - | - | 0* | not used (must write a logic 0) |
| 6 | - | - | 0* | not used (must write a logic 0) |
| 5 | DMBLNK | write only | 0* | group control = dimming. |
| | | | 1 | group control = blinking. |
| 4 | - | - | 0* | reserved (must write a logic 0) |
| 3 | OCH | write only | 0* | outputs change on STOP command |
| | | | 1 | outputs change on ACK; this ninth bit is always set to 1 by U ² C-bus master |
| 2 | - | - | 1* | reserved (must write a logic 1) |
| 1 | - | - | 0* | reserved (must write a logic 0) |
| 0 | - | - | 1* | reserved (must write a logic 1) |

7.3.3 LEDOUT0 to LEDOUT5, LED driver output state

Table 10. LEDOUT0 to LEDOUT5 - LED driver output state registers (address 02h to 07h) bit description

Legend: * default value.

| Address | Register | Bit | Symbol | Access | Value | Description |
|---------|----------|-----|--------|------------|-------|----------------------------|
| 02h | LEDOUT0 | 7:6 | LDR3 | write only | 10* | LED3 output state control |
| | | 5:4 | LDR2 | write only | 10* | LED2 output state control |
| | | 3:2 | LDR1 | write only | 10* | LED1 output state control |
| | | 1:0 | LDR0 | write only | 10* | LED0 output state control |
| 03h | LEDOUT1 | 7:6 | LDR7 | write only | 10* | LED7 output state control |
| | | 5:4 | LDR6 | write only | 10* | LED6 output state control |
| | | 3:2 | LDR5 | write only | 10* | LED5 output state control |
| | | 1:0 | LDR4 | write only | 10* | LED4 output state control |
| 04h | LEDOUT2 | 7:6 | LDR11 | write only | 10* | LED11 output state control |
| | | 5:4 | LDR10 | write only | 10* | LED10 output state control |
| | | 3:2 | LDR9 | write only | 10* | LED9 output state control |
| | | 1:0 | LDR8 | write only | 10* | LED8 output state control |
| 05h | LEDOUT3 | 7:6 | LDR15 | write only | 10* | LED15 output state control |
| | | 5:4 | LDR14 | write only | 10* | LED14 output state control |
| | | 3:2 | LDR13 | write only | 10* | LED13 output state control |
| | | 1:0 | LDR12 | write only | 10* | LED12 output state control |
| 06h | LEDOUT4 | 7:6 | LDR19 | write only | 10* | LED19 output state control |
| | | 5:4 | LDR18 | write only | 10* | LED18 output state control |
| | | 3:2 | LDR17 | write only | 10* | LED17 output state control |
| | | 1:0 | LDR16 | write only | 10* | LED16 output state control |
| 07h | LEDOUT5 | 7:6 | LDR23 | write only | 10* | LED23 output state control |
| | | 5:4 | LDR22 | write only | 10* | LED22 output state control |
| | | 3:2 | LDR21 | write only | 10* | LED21 output state control |
| | | 1:0 | LDR20 | write only | 10* | LED20 output state control |

LDRx = 00 — LED driver x is off (x = 0 to 23).

LDRx = 01 — LED driver x is fully on (individual brightness and group dimming/blinking not controlled). The \overline{OE} pin can be used as external dimming/blinking control in this state.

LDRx = 10 — LED driver x individual brightness can be controlled through its PWMx register (default power-up state).

LDRx = 11 — LED driver x individual brightness and group dimming/blinking can be controlled through its PWMx register and the GRPPWM registers.

7.3.4 GRPPWM, group duty cycle control

Table 11. GRPPWM - Group brightness control register (address 08h) bit description

Legend: * default value

| Address | Register | Bit | Symbol | Access | Value | Description |
|---------|----------|-----|----------|------------|------------|-----------------|
| 08h | GRPPWM | 7:0 | GDC[7:0] | write only | 1111 1111* | GRPPWM register |

When DMBLNK bit (MODE2 register) is programmed with logic 0, a 122 Hz fixed frequency signal is superimposed with the 31.25 kHz individual brightness control signal. GRPPWM is then used as a global brightness control allowing the LED outputs to be dimmed with the same value. The value in GRPFREQ is then a ‘Don’t care’.

General brightness for the 24 outputs is controlled through 256 linear steps from 00h (0 % duty cycle = LED output off) to FFh (99.6 % duty cycle = maximum brightness). Applicable to LED outputs programmed with LDRx = 11 (LEDOUT0 to LEDOUT5 registers).

When DMBLNK bit is programmed with logic 1, GRPPWM and GRPFREQ registers define a global blinking pattern, where GRPFREQ contains the blinking period (from 67 ms to 16.8 s) and GRPPWM the duty cycle (ON/OFF ratio in %).

$$duty\ cycle = \frac{GDC[7:0]}{256} \tag{1}$$

7.3.5 GRPFREQ, group frequency

Table 12. GRPFREQ - Group frequency register (address 09h) bit description

Legend: * default value.

| Address | Register | Bit | Symbol | Access | Value | Description |
|---------|----------|-----|-----------|------------|------------|------------------|
| 09h | GRPFREQ | 7:0 | GFRQ[7:0] | write only | 0000 0000* | GRPFREQ register |

GRPFREQ is used to program the global blinking period when DMBLNK bit (MODE2 register) is equal to 1. Value in this register is a ‘Don’t care’ when DMBLNK = 0. Applicable to LED outputs programmed with LDRx = 11 (LEDOUT0 to LEDOUT5 registers).

Blinking period is controlled through 256 linear steps from 00h (67 ms, frequency 15 Hz) to FFh (16.8 s).

$$global\ blinking\ period = \frac{GFRQ[7:0] + 1}{15.26} (s) \tag{2}$$

7.3.6 PWM0 to PWM23, individual brightness control

Table 13. PWM0 to PWM23 - PWM registers 0 to 23 (address 0Ah to 21h) bit description
 Legend: * default value.

| Address | Register | Bit | Symbol | Access | Value | Description |
|---------|----------|-----|------------|------------|------------|-----------------------------|
| 0Ah | PWM0 | 7:0 | IDC0[7:0] | write only | 0000 0000* | PWM0 Individual Duty Cycle |
| 0Bh | PWM1 | 7:0 | IDC1[7:0] | write only | 0000 0000* | PWM1 Individual Duty Cycle |
| 0Ch | PWM2 | 7:0 | IDC2[7:0] | write only | 0000 0000* | PWM2 Individual Duty Cycle |
| 0Dh | PWM3 | 7:0 | IDC3[7:0] | write only | 0000 0000* | PWM3 Individual Duty Cycle |
| 0Eh | PWM4 | 7:0 | IDC4[7:0] | write only | 0000 0000* | PWM4 Individual Duty Cycle |
| 0Fh | PWM5 | 7:0 | IDC5[7:0] | write only | 0000 0000* | PWM5 Individual Duty Cycle |
| 10h | PWM6 | 7:0 | IDC6[7:0] | write only | 0000 0000* | PWM6 Individual Duty Cycle |
| 11h | PWM7 | 7:0 | IDC7[7:0] | write only | 0000 0000* | PWM7 Individual Duty Cycle |
| 12h | PWM8 | 7:0 | IDC8[7:0] | write only | 0000 0000* | PWM8 Individual Duty Cycle |
| 13h | PWM9 | 7:0 | IDC9[7:0] | write only | 0000 0000* | PWM9 Individual Duty Cycle |
| 14h | PWM10 | 7:0 | IDC10[7:0] | write only | 0000 0000* | PWM10 Individual Duty Cycle |
| 15h | PWM11 | 7:0 | IDC11[7:0] | write only | 0000 0000* | PWM11 Individual Duty Cycle |
| 16h | PWM12 | 7:0 | IDC12[7:0] | write only | 0000 0000* | PWM12 Individual Duty Cycle |
| 17h | PWM13 | 7:0 | IDC13[7:0] | write only | 0000 0000* | PWM13 Individual Duty Cycle |
| 18h | PWM14 | 7:0 | IDC14[7:0] | write only | 0000 0000* | PWM14 Individual Duty Cycle |
| 19h | PWM15 | 7:0 | IDC15[7:0] | write only | 0000 0000* | PWM15 Individual Duty Cycle |
| 1Ah | PWM16 | 7:0 | IDC16[7:0] | write only | 0000 0000* | PWM16 Individual Duty Cycle |
| 1Bh | PWM17 | 7:0 | IDC17[7:0] | write only | 0000 0000* | PWM17 Individual Duty Cycle |
| 1Ch | PWM18 | 7:0 | IDC18[7:0] | write only | 0000 0000* | PWM18 Individual Duty Cycle |
| 1Dh | PWM19 | 7:0 | IDC19[7:0] | write only | 0000 0000* | PWM19 Individual Duty Cycle |
| 1Eh | PWM20 | 7:0 | IDC20[7:0] | write only | 0000 0000* | PWM20 Individual Duty Cycle |
| 1Fh | PWM21 | 7:0 | IDC21[7:0] | write only | 0000 0000* | PWM21 Individual Duty Cycle |
| 20h | PWM22 | 7:0 | IDC22[7:0] | write only | 0000 0000* | PWM22 Individual Duty Cycle |
| 21h | PWM23 | 7:0 | IDC23[7:0] | write only | 0000 0000* | PWM23 Individual Duty Cycle |

A 31.25 kHz fixed frequency signal is used for each output. Duty cycle is controlled through 256 linear steps from 00h (0 % duty cycle = LED output off) to FFh (99.6 % duty cycle = LED output at maximum brightness). Applicable to LED outputs programmed with LDRx = 10 or 11 (LEDOUT0 to LEDOUT5 registers).

$$duty\ cycle = \frac{IDC_x[7:0]}{256} \tag{3}$$

Remark: The first lower end 8 steps of PWM and the last (higher end) steps of PWM will not have effective brightness control of LEDs due to edge rate control of LED output pins.

7.3.7 IREF0 to IREF23, LED output current value registers

These registers reflect the gain settings for output current for LED0 to LED23.

Table 14. IREF0 to IREF23 - LED output gain control registers (address 22h to 39h) bit description

Legend: * default value.

| Address | Register | Bit | Access | Value | Description |
|---------|----------|-----|------------|-------|------------------------------|
| 22h | IREF0 | 7:0 | write only | 00h* | LED0 output current setting |
| 23h | IREF1 | 7:0 | write only | 00h* | LED1 output current setting |
| 24h | IREF2 | 7:0 | write only | 00h* | LED2 output current setting |
| 25h | IREF3 | 7:0 | write only | 00h* | LED3 output current setting |
| 26h | IREF4 | 7:0 | write only | 00h* | LED4 output current setting |
| 27h | IREF5 | 7:0 | write only | 00h* | LED5 output current setting |
| 28h | IREF6 | 7:0 | write only | 00h* | LED6 output current setting |
| 29h | IREF7 | 7:0 | write only | 00h* | LED7 output current setting |
| 2Ah | IREF8 | 7:0 | write only | 00h* | LED8 output current setting |
| 2Bh | IREF9 | 7:0 | write only | 00h* | LED9 output current setting |
| 2Ch | IREF10 | 7:0 | write only | 00h* | LED10 output current setting |
| 2Dh | IREF11 | 7:0 | write only | 00h* | LED11 output current setting |
| 2Eh | IREF12 | 7:0 | write only | 00h* | LED12 output current setting |
| 2Fh | IREF13 | 7:0 | write only | 00h* | LED13 output current setting |
| 30h | IREF14 | 7:0 | write only | 00h* | LED14 output current setting |
| 31h | IREF15 | 7:0 | write only | 00h* | LED15 output current setting |
| 32h | IREF16 | 7:0 | write only | 00h* | LED16 output current setting |
| 33h | IREF17 | 7:0 | write only | 00h* | LED17 output current setting |
| 34h | IREF18 | 7:0 | write only | 00h* | LED18 output current setting |
| 35h | IREF19 | 7:0 | write only | 00h* | LED19 output current setting |
| 36h | IREF20 | 7:0 | write only | 00h* | LED20 output current setting |
| 37h | IREF21 | 7:0 | write only | 00h* | LED21 output current setting |
| 38h | IREF22 | 7:0 | write only | 00h* | LED22 output current setting |
| 39h | IREF23 | 7:0 | write only | 00h* | LED23 output current setting |

7.3.8 OFFSET — LED_n output delay offset register

Table 15. OFFSET - LED_n output delay offset register (address 3Ah) bit description

Legend: * default value.

| Address | Register | Bit | Access | Value | Description |
|---------|----------|-----|------------|-------|---|
| 3Ah | OFFSET | 7:4 | - | 0000* | not used (must write a logic 0) |
| | | 3:0 | write only | 1000* | LED _n output delay offset factor |

The PCU9956A can be programmed to have turn-on delay between LED outputs. This helps to reduce peak current for the V_{DD} supply and reduces EMI.

The order in which the LED outputs are enabled will always be the same (channel 0 will enable first and channel 23 will enable last).

OFFSET control register bits [3:0] determine the delay used between the turn-on times as follows:

- 0000 = no delay between outputs (all on, all off at the same time)
- 0001 = delay of 1 clock cycle (125 ns) between successive outputs
- 0010 = delay of 2 clock cycles (250 ns) between successive outputs
- 0011 = delay of 3 clock cycles (375 ns) between successive outputs
- :
- 0111 = delay of 7 clock cycles (875 ns) between successive outputs
- 1000 = delay of 8 clock cycles (1 μs) between successive outputs
- 1001 = delay of 9 clock cycles (1.125 μs) between successive outputs
- 1010 = delay of 10 clock cycles (1.25 μs) between successive outputs
- 1011 = delay of 11 clock cycles (1.375 μs) between successive outputs
- 1100 to 1111 = reserved and do not use

Example: If the value in the OFFSET register is 1000 the corresponding delay = $8 \times 125 \text{ ns} = 1 \mu\text{s}$ delay between successive outputs.

- channel 0 turns on at time 0 μs
- channel 1 turns on at time 1 μs
- channel 2 turns on at time 2 μs
- channel 3 turns on at time 3 μs
- channel 4 turns on at time 4 μs
- channel 5 turns on at time 5 μs
- channel 6 turns on at time 6 μs
- channel 7 turns on at time 7 μs
- channel 8 turns on at time 8 μs
- channel 9 turns on at time 9 μs
- channel 10 turns on at time 10 μs
- channel 11 turns on at time 11 μs
- channel 12 turns on at time 12 μs
- channel 13 turns on at time 13 μs

channel 14 turns on at time 14 μs
 channel 15 turns on at time 15 μs
 channel 16 turns on at time 16 μs
 channel 17 turns on at time 17 μs
 channel 18 turns on at time 18 μs
 channel 19 turns on at time 19 μs
 channel 20 turns on at time 20 μs
 channel 21 turns on at time 21 μs
 channel 22 turns on at time 22 μs
 channel 23 turns on at time 23 μs

7.3.9 LED Sub Call I²C-bus addresses for PCU9956A

Table 16. SUBADR1 to SUBADR3 - I²C-bus subaddress registers 1 to 3 (address 3Bh to 3Dh) bit description

Legend: * default value.

| Address | Register | Bit | Symbol | Access | Value | Description |
|---------|----------|-----|---------|------------|-----------|-----------------------------------|
| 3Bh | SUBADR1 | 7:1 | A1[7:1] | write only | 1110 111* | I ² C-bus subaddress 1 |
| | | 0 | A1[0] | write only | 0* | reserved |
| 3Ch | SUBADR2 | 7:1 | A2[7:1] | write only | 1110 111* | I ² C-bus subaddress 2 |
| | | 0 | A2[0] | write only | 0* | reserved |
| 3Dh | SUBADR3 | 7:1 | A3[7:1] | write only | 1110 111* | I ² C-bus subaddress 3 |
| | | 0 | A3[0] | write only | 0* | reserved |

Default power-up values are EEh, EEh, EEh. At power-up, SUBADR1 is enabled while SUBADR2 and SUBADR3 are disabled. The power-up default bit subaddress of EEh indicates that this device is a 24-channel LED driver.

All three subaddresses are programmable. Once subaddresses have been programmed to their right values, SUBx bits need to be set to logic 1 in order to have the device respond to these addresses (MODE1 register) (0). When SUBx is set to logic 1, the corresponding I²C-bus subaddress can be used during a U^Fm I²C-bus write sequence.

7.3.10 ALLCALLADR, LED All Call I²C-bus address

Table 17. ALLCALLADR - LED All Call I²C-bus address register (address 3Eh) bit description

Legend: * default value.

| Address | Register | Bit | Symbol | Access | Value | Description |
|---------|------------|-----|---------|------------|-----------|---|
| 3Eh | ALLCALLADR | 7:1 | AC[7:1] | write only | 1110 000* | ALLCALL I ² C-bus address register |
| | | 0 | AC[0] | write only | 0* | reserved |

The LED All Call I²C-bus address allows all the PCU9956As on the bus to be programmed at the same time (ALLCALL bit in register MODE1 must be equal to logic 1 [power-up default state]). This address is programmable through the I²C-bus and can be used during an I²C-bus write sequence. The register address can also be programmed as a Sub Call.

Only the 7 MSBs representing the All Call I²C-bus address are valid. The LSB in ALLCALLADR register must write a logic 0.

If ALLCALL bit = 0 in MODE1 register, the device does not recognize the address programmed in register ALLCALLADR.

7.3.11 PWMALL — brightness control for all LEDn outputs

When programmed, the value in this register will be used for PWM duty cycle for all the LEDn outputs and will be reflected in PWM 0 through PWM23 registers.

Table 18. PWMALL - brightness control for all LEDn outputs register (address 3Fh) bit description

Legend: * default value.

| Address | Register | Bit | Access | Value | Description |
|---------|----------|-----|------------|------------|---------------------------------|
| 3Fh | PWMALL | 7:0 | write only | 0000 0000* | duty cycle for all LEDn outputs |

Remark: Write to any of the PWM0 to PWM23 registers will overwrite the value in corresponding PWMn register programmed by PWMALL.

7.3.12 IREFALL register: output current value for all LED outputs

The output current setting for all outputs is held in this register. When this register is written to or updated, all LED outputs will be set to a current corresponding to this register value.

Writes to IREF0 to IREF23 will overwrite the output current settings.

Table 19. IREFALL - Output gain control for all LED outputs (address 40h) bit description

Legend: * default value.

| Address | Register | Bit | Access | Value | Description |
|---------|----------|-----|------------|-------|--|
| 40h | IREFALL | 7:0 | write only | 00h* | current gain setting for all LED outputs |

7.3.13 LED driver constant current outputs

In LED display applications, PCU9956A provides nearly no current variations from channel to channel and from device to device. The maximum current skew between channels is less than ±4 % and less than ±6 % between devices.

7.3.13.1 Adjusting output current

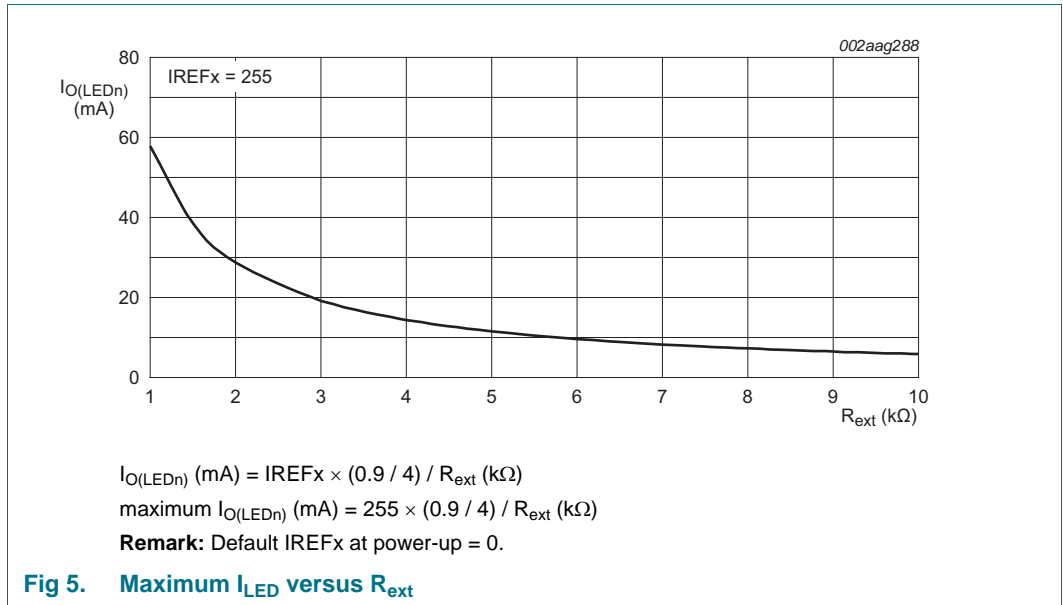
The PCU9956A scales up the reference current (I_{ref}) set by the external resistor (R_{ext}) to sink the output current (I_O) at each output port. The maximum output current for the outputs can be set using R_{ext} . In addition, the constant value for current drive at each of the outputs is independently programmable using command registers IREF0 to IREF23. Alternatively, programming the IREFALL register allows all outputs to be set at one current value determined by the value in IREFALL register.

[Equation 4](#) and [Equation 5](#) can be used to calculate the minimum and maximum constant current values that can be programmed for the outputs for a chosen R_{ext} .

$$I_{O_LED_MIN} = \frac{900 \text{ mV}}{R_{ext}} \times \frac{1}{4} \text{ (minimum constant current)} \tag{4}$$

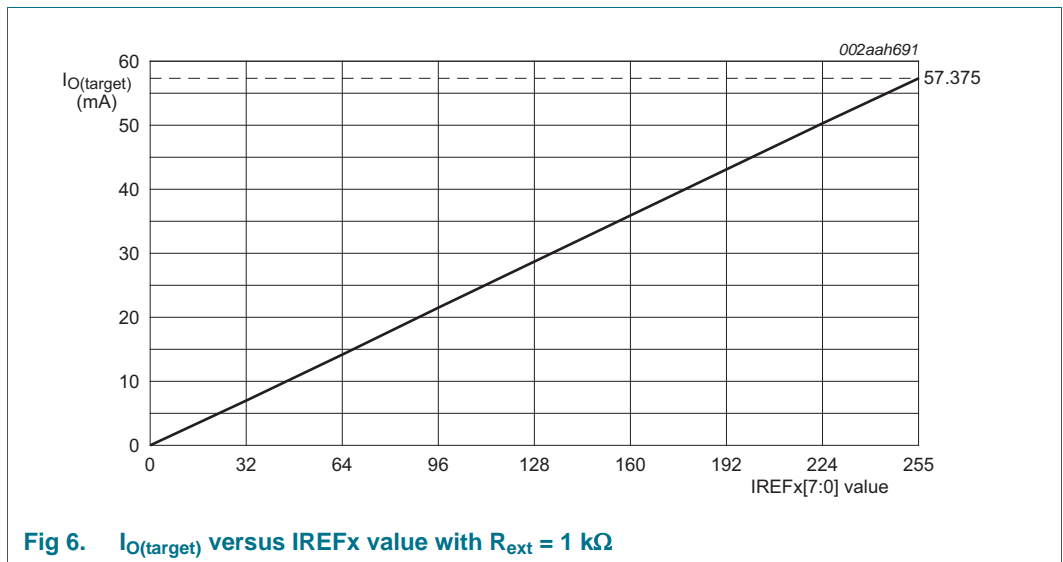
$$I_{O_LED_MAX} = (255 \times I_{O_LED_MIN}) = \left(\frac{900 \text{ mV}}{R_{ext}} \times \frac{255}{4} \right) \tag{5}$$

For a given IREFx setting, $I_{O_LED} = IREFx \times \frac{900\text{ mV}}{R_{ext}} \times \frac{1}{4}$.



Example 1: If $R_{ext} = 1\text{ k}\Omega$, $I_{O_LED_MIN} = 225\ \mu\text{A}$, $I_{O_LED_MAX} = 57.375\text{ mA}$ (as shown in [Figure 6](#)).

So each channel can be programmed with its individual IREFx in 256 steps and in 225 μA increments to a maximum output current of 57.375 mA independently.



Example 2: If $R_{ext} = 2\text{ k}\Omega$, $I_{O_LED_MIN} = 112.5\ \mu\text{A}$, $I_{O_LED_MAX} = 28.687\ \text{mA}$ (as shown in [Figure 7](#)).

So each channel can be programmed with its individual IREFx in 256 steps and in 112.5 μA increments to a maximum output channel of 28.687 mA independently.

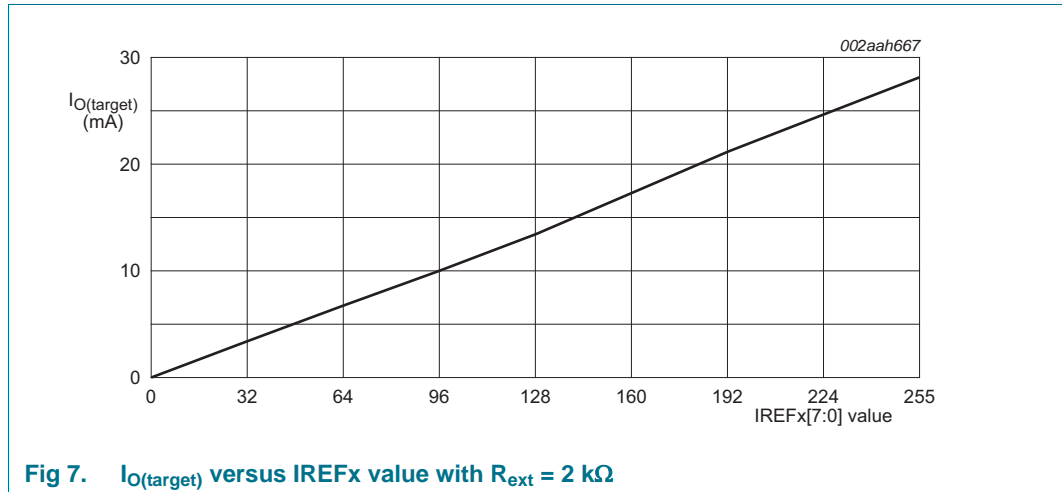


Fig 7. I_{O(target)} versus IREFx value with $R_{ext} = 2\text{ k}\Omega$

7.3.14 Overtemperature protection

If the PCU9956A chip temperature exceeds its limit (T_{max} , see [Table 22](#)), all output channels will be disabled until the temperature drops below its limit minus a small hysteresis (T_{hys} , see [Table 22](#)). Once the die temperature reduces below the $T_{max} - T_{hys}$, the chip will return to the same condition it was prior to the overtemperature event.

7.4 Active LOW output enable input

The active LOW output enable (\overline{OE}) pin on PCU9956A allows to enable or disable all the LED outputs at the same time.

- When a LOW level is applied to \overline{OE} pin, all the LED outputs are enabled.
- When a HIGH level is applied to \overline{OE} pin, all the LED outputs are high-impedance.

The \overline{OE} pin can be used as a synchronization signal to switch on/off several PCU9956A devices at the same time when LED drive output state is set fully ON ($LDRx = 01$ in LEDOUTx register) in these devices. This requires an external clock reference that provides blinking period and the duty cycle.

The \overline{OE} pin can also be used as an external dimming control signal. The frequency of the external clock must be high enough not to be seen by the human eye, and the duty cycle value determines the brightness of the LEDs.

Remark: Do not use \overline{OE} as an external blinking control signal when internal global blinking is selected ($DMBLNK = 1$, MODE2 register) since it will result in an undefined blinking pattern. Do not use \overline{OE} as an external dimming control signal when internal global dimming is selected ($DMBLNK = 0$, MODE2 register) since it will result in an undefined dimming pattern.

7.5 Power-on reset

When power is applied to V_{DD}, an internal power-on reset holds the PCU9956A in a reset condition until V_{DD} has reached V_{POR}. At this point, the reset condition is released and the PCU9956A registers and I²C-bus state machine are initialized to their default states (all zeroes) causing all the channels to be deselected. Thereafter, V_{DD} must be pulled lower than 1 V and stay LOW for longer than 20 μs. The device will reset itself, and allow 2 ms for the device to fully wake up.

7.6 Hardware reset recovery

When a reset of PCU9956A is activated using an active LOW input on the RESET pin, a reset pulse width of 2.5 μs minimum is required. The maximum wait time after RESET pin is released is 1.5 ms.

7.7 Software reset

The Software Reset Call (SWRST Call) allows all the devices in the I²C-bus to be reset to the power-up state value through a specific formatted I²C-bus command. To be performed correctly, it implies that the I²C-bus is functional and that there is no device hanging the bus.

The maximum wait time after software reset is 1 ms.

The SWRST Call function is defined as the following:

1. A START command is sent by the I²C-bus master.
2. The reserved General Call address '0000 000' with the R/W bit set to '0' (write) is sent by the I²C-bus master.
3. Since PCU9956A is a U^{Fm} I²C-bus device, no acknowledge is returned to the I²C-bus master.
4. Once the General Call address has been sent, the master sends 1 byte with 1 specific value (SWRST data byte 1): Byte 1 = 06h.

If more than 1 byte of data is sent, they will be ignored by the PCU9956A.

5. Once the correct byte (SWRST data byte 1) has been sent, the master sends a STOP command to end the SWRST function: the PCU9956A then resets to the default value (power-up value) and is ready to be addressed again within the specified bus free time (t_{BUF}).

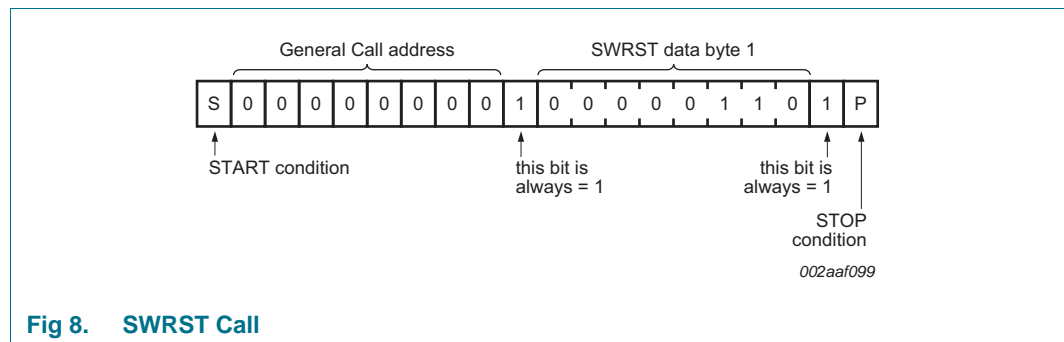


Fig 8. SWRST Call

7.8 Individual brightness control with group dimming/blinking

A 31.25 kHz fixed frequency signal with programmable duty cycle (8 bits, 256 steps) is used to control individually the brightness for each LED.

On top of this signal, one of the following signals can be superimposed (this signal can be applied to the 24 LED outputs LED0 to LED23).

- A lower 122 Hz fixed frequency signal with programmable duty cycle (8 bits, 256 steps) is used to provide a global brightness control.
- A programmable frequency signal from 15 Hz to every 16.8 seconds (8 bits, 256 steps) with programmable duty cycle (8 bits, 256 steps) is used to provide a global blinking control.

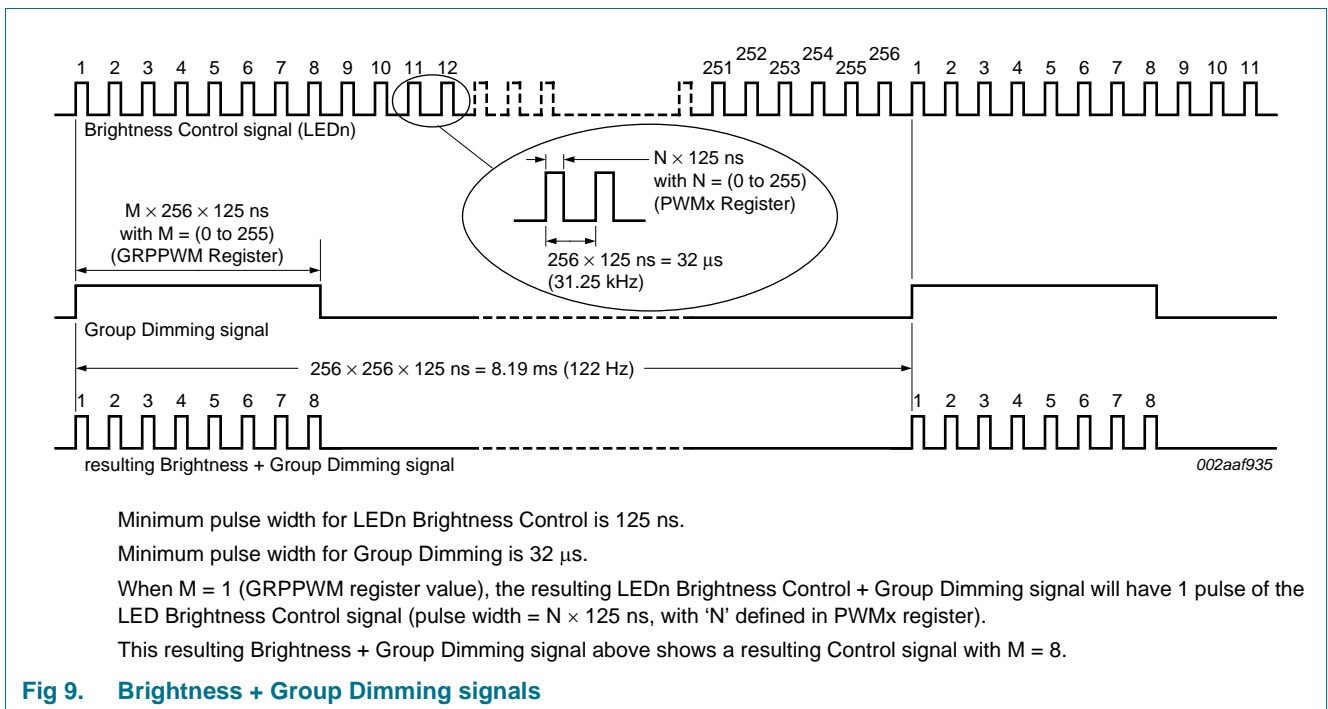


Fig 9. Brightness + Group Dimming signals

8. Characteristics of the PCU9956A Ultra Fast-mode I²C-bus

The PCU9956A LED controller uses the new Ultra Fast-mode (U^Fm) I²C-bus to communicate with the U^Fm I²C-bus capable host controller. Like the Standard mode and Fast-mode Plus (Fm+) I²C-bus, it uses two lines for communication. They are a serial data line (USDA) and a serial clock line (USCL). The U^Fm is a unidirectional bus that is capable of higher frequency (up to 5 MHz). The U^Fm I²C-bus slave devices operate in receive-only mode. That is, only I²C writes to PCU9956A are supported.

8.1 Bit transfer

One data bit is transferred during each clock pulse. The data on the USDA line must remain stable during the HIGH period of the clock pulse as changes in the data line at this time will be interpreted as control signals (see [Figure 10](#)).

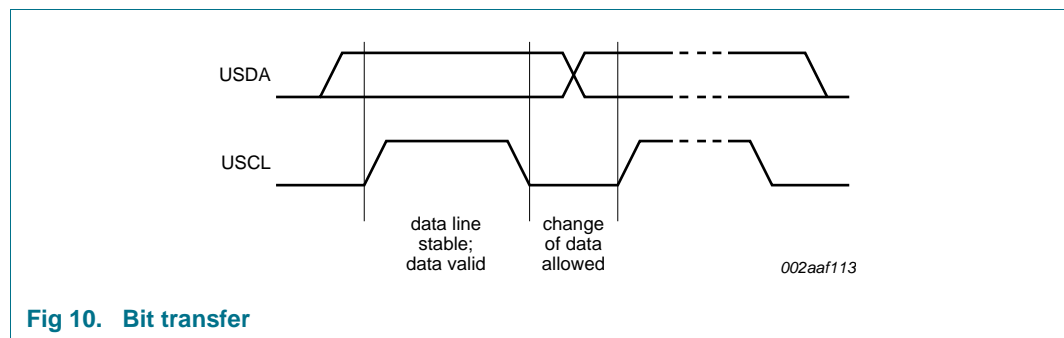


Fig 10. Bit transfer

8.1.1 START and STOP conditions

Both data and clock lines remain HIGH when the bus is not busy. A HIGH-to-LOW transition of the data line while the clock is HIGH is defined as the START condition (S). A LOW-to-HIGH transition of the data line while the clock is HIGH is defined as the STOP condition (P) (see [Figure 11](#)).

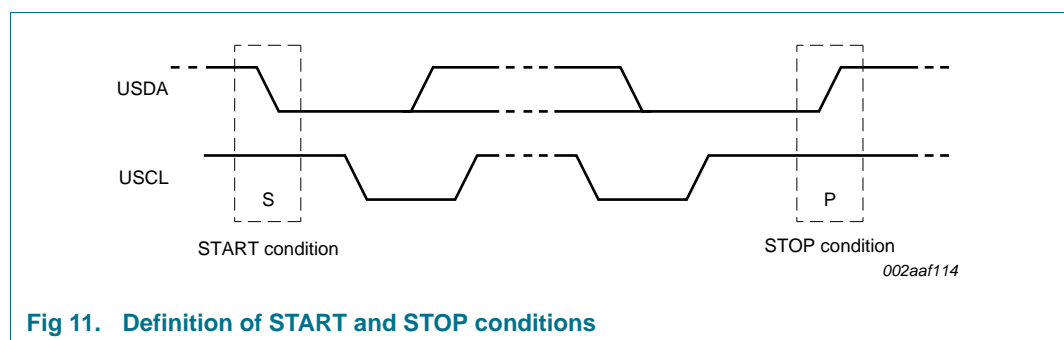


Fig 11. Definition of START and STOP conditions

8.2 System configuration

A device generating a message is a ‘transmitter’; a device receiving is the ‘receiver’. The device that controls the message is the ‘master’ and the devices which are controlled by the master are the ‘slaves’ (see [Figure 12](#)).

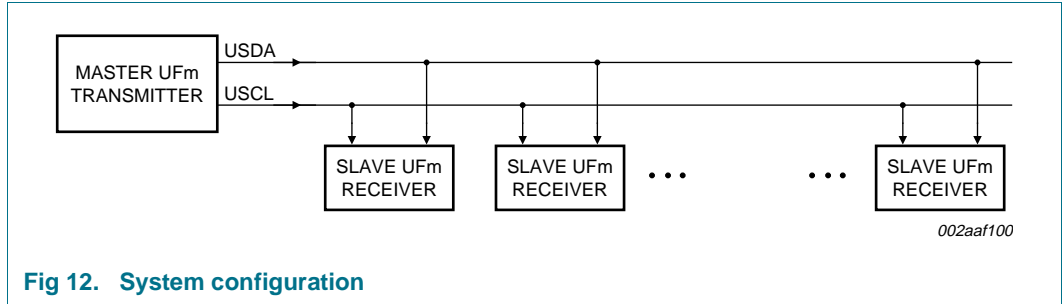


Fig 12. System configuration

8.3 Data transfer

The number of data bytes transferred between the START and the STOP conditions from transmitter to receiver is not limited. Each byte of eight bits is followed by one bit that is always set to 1. The master generates an extra related clock pulse.

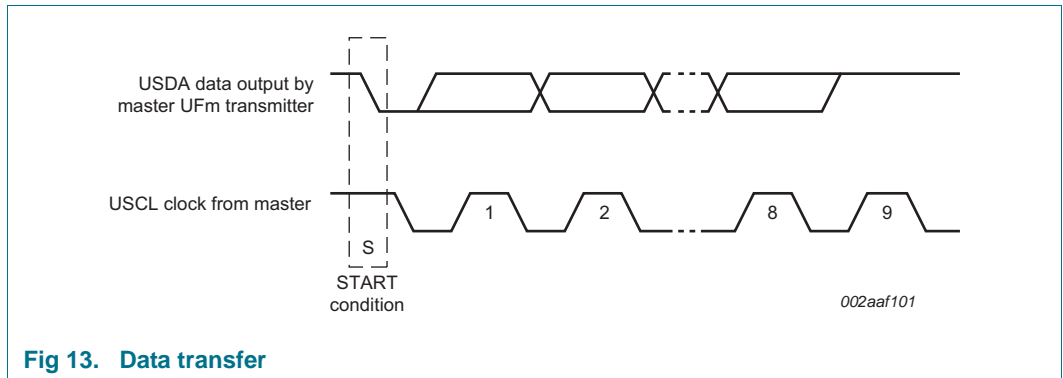
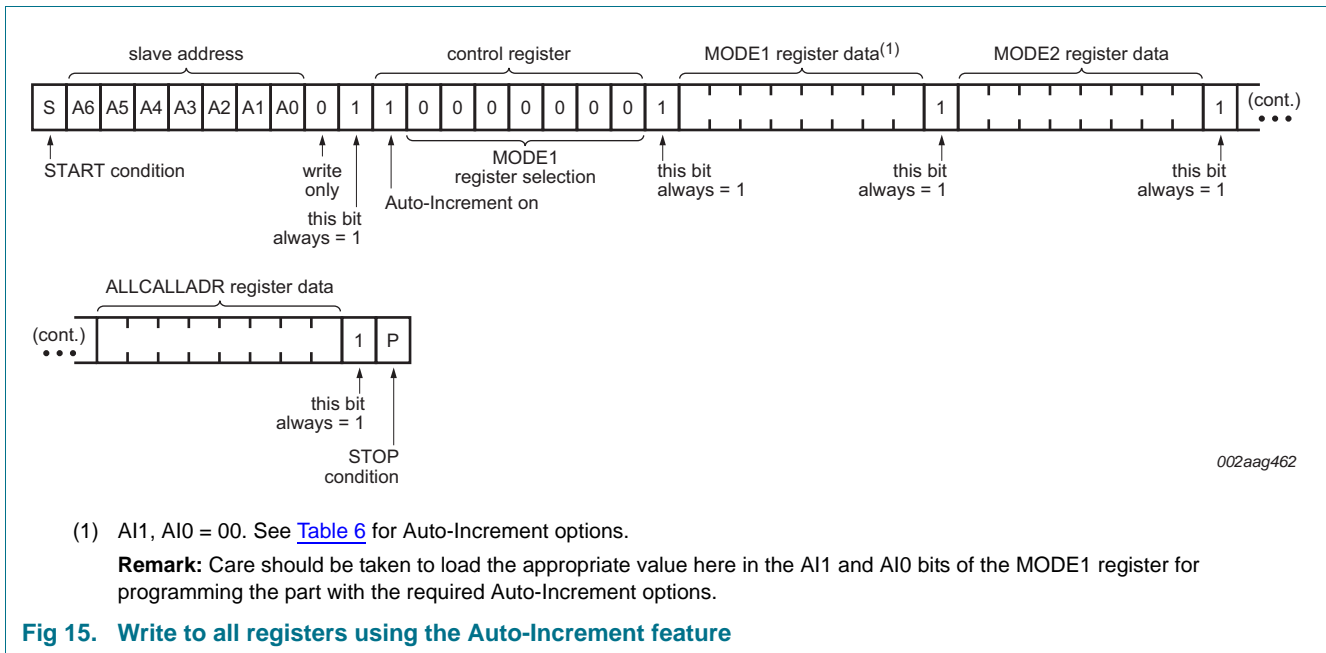
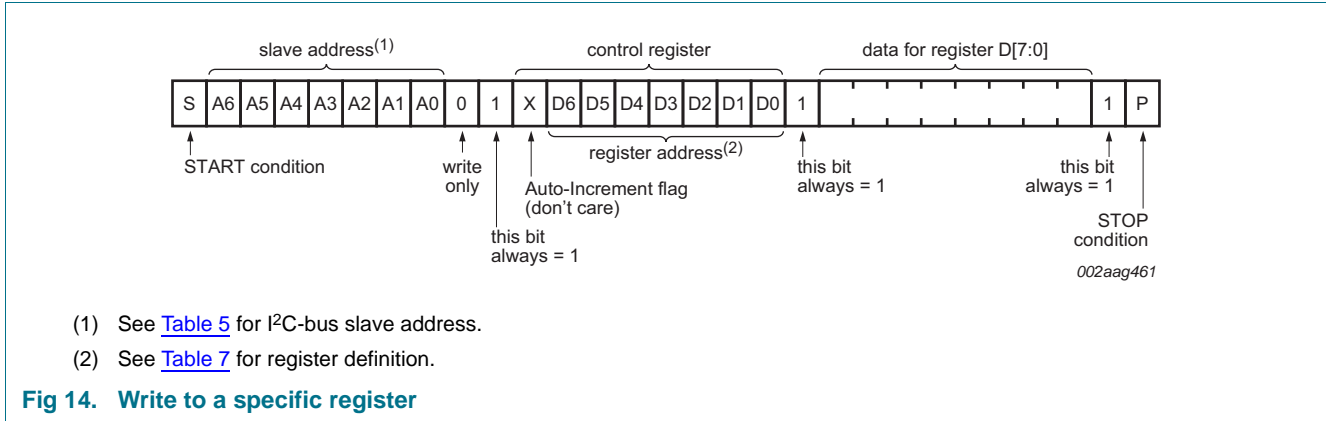
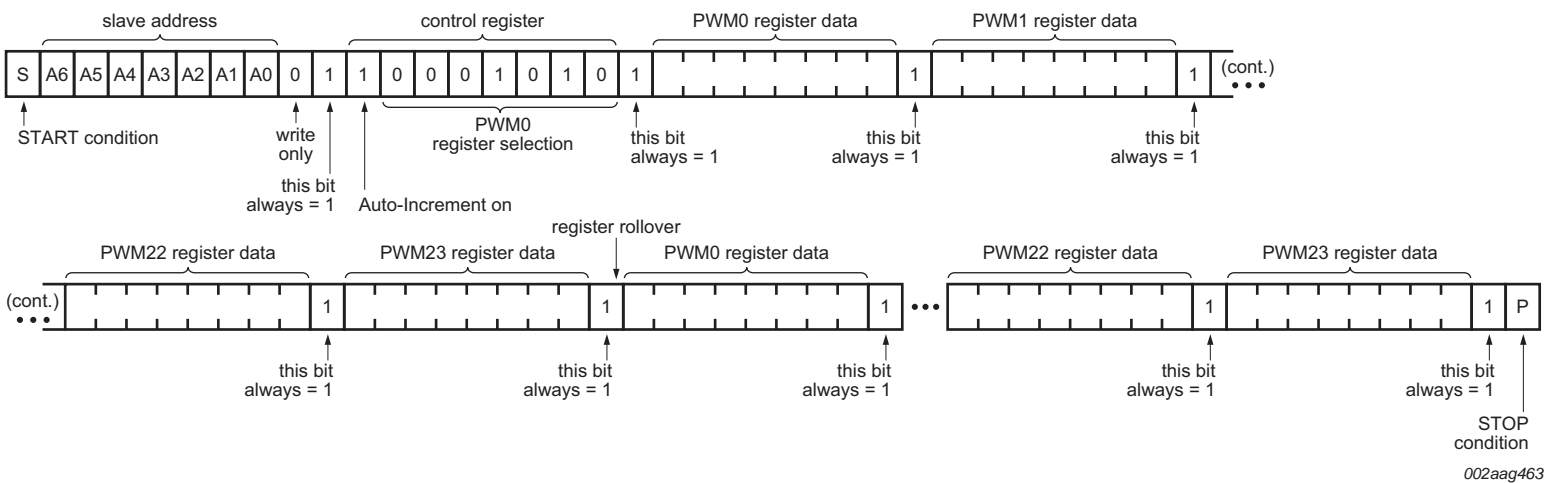


Fig 13. Data transfer

9. Bus transactions

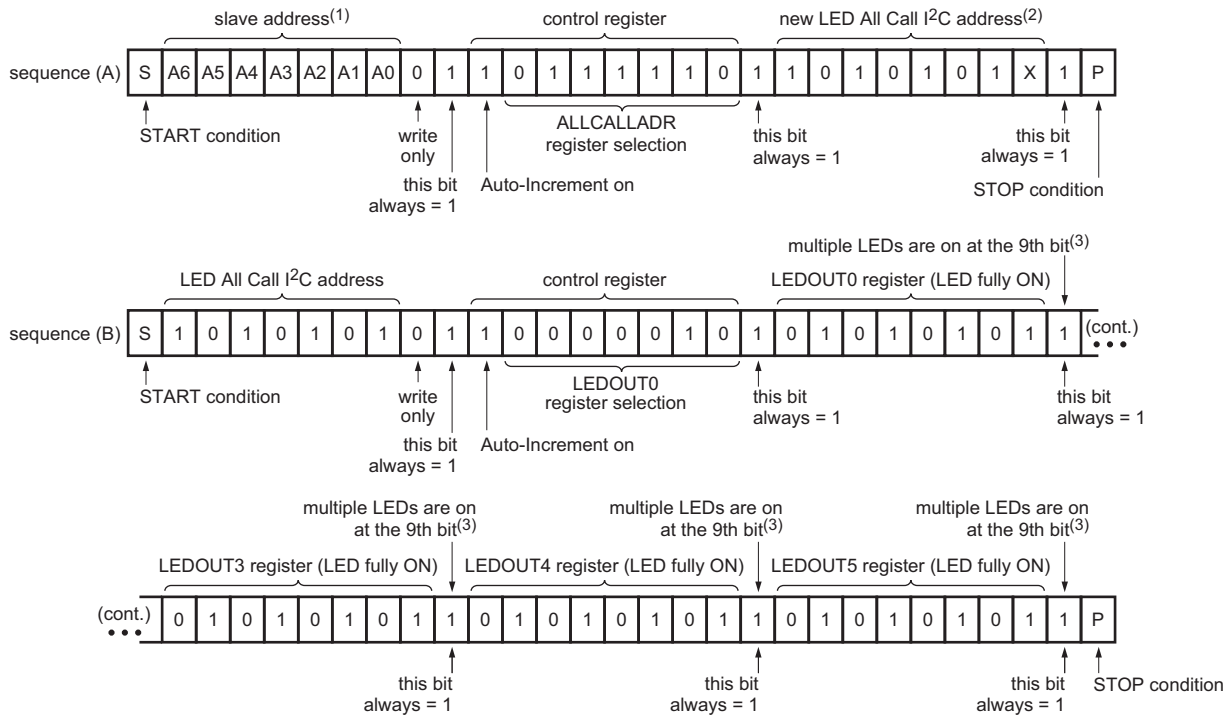




This example assumes that AIF + AI[1:0] = 101b.

Fig 16. Multiple writes to Individual Brightness registers only using the Auto-Increment feature

002aag463

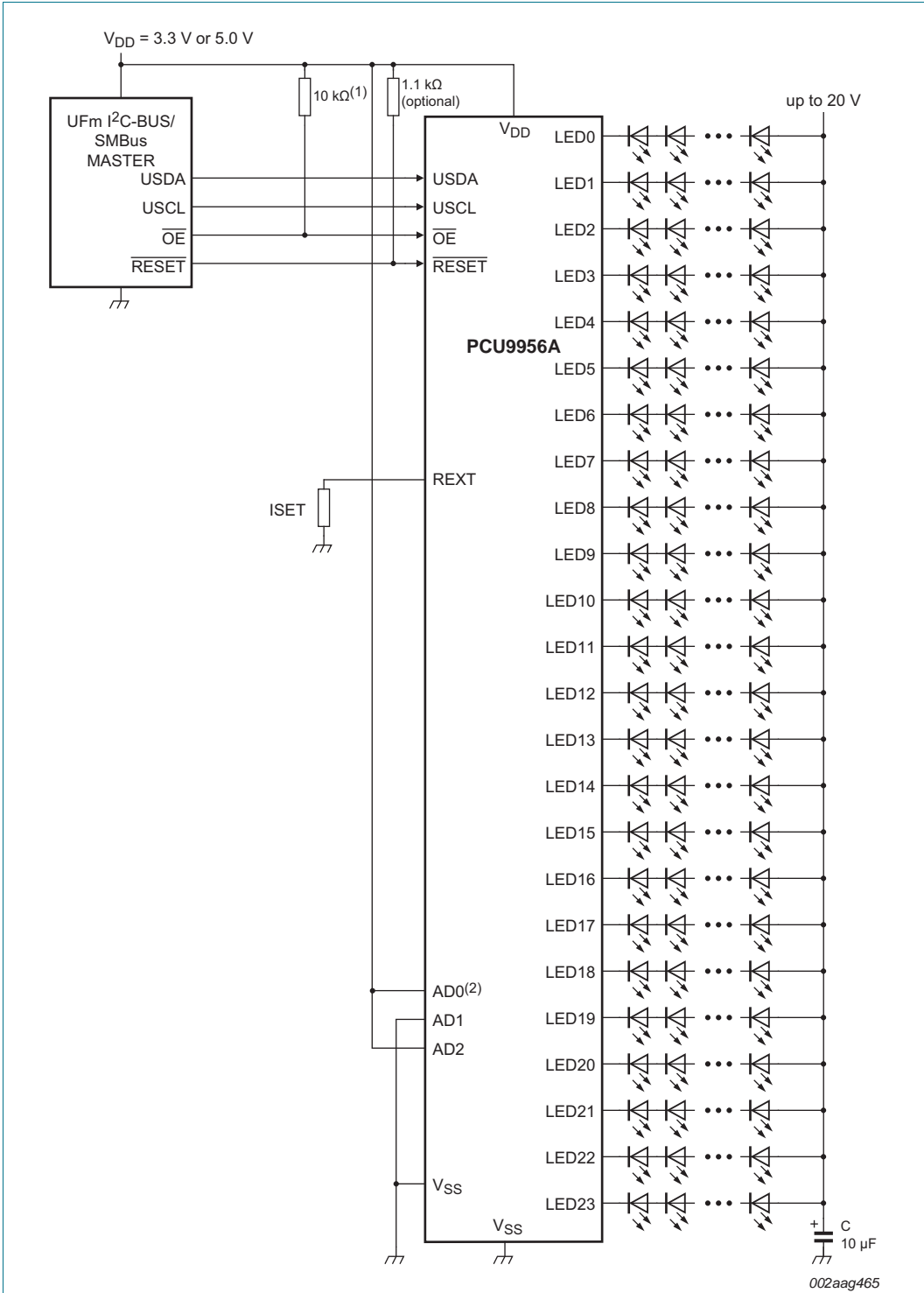


002aah722

- (1) In this example, several PCU9956As are used and the same sequence (A) (above) is sent to each of them.
- (2) ALLCALL bit in MODE1 register is previously set to 1 for this example.
- (3) OCH bit in MODE2 register is previously set to 1 for this example.

Fig 17. LED All Call I²C-bus address programming and LED All Call sequence example

10. Application design-in information



- (1) OE requires pull-up resistor if control signal from the master is open-drain.
- (2) I²C-bus address = 1101001 when AD0, AD2 tied to V_{DD} and AD1 tied to V_{SS} (see Table 5).

Fig 18. Typical application

10.1 Thermal considerations

Since the PCU9956A device integrates 24 linear current sources, thermal considerations should be taken into account to prevent overheating, which can cause the device to go into thermal shutdown.

Perhaps the major contributor for device's overheating is the LED forward voltage mismatch. This is because it can cause significant voltage differences between the LED strings of the same type (e.g., 2 V to 3 V), which ultimately translates into higher power dissipation in the device. The voltage drop across the LED channels of the device is given by the difference between the supply voltage and the LED forward voltage of each LED string. Reducing this to a minimum (e.g., 0.8 V) helps to keep the power dissipation down. Therefore LEDs binning is recommended to minimize LED voltage forward variation and reduce power dissipation in the device.

In order to ensure that the device will not go into thermal shutdown when operating under certain application conditions, its junction temperature (T_j) should be calculated to ensure that is below the overtemperature threshold limit (130 °C). The T_j of the device depends on the ambient temperature (T_{amb}), device's total power dissipation (P_{tot}), and thermal resistance.

The device junction temperature can be calculated by using the following equation:

$$T_j = T_{amb} + R_{th(j-a)} \times P_{tot} \quad (6)$$

where:

T_j = junction temperature

T_{amb} = ambient temperature

$R_{th(j-a)}$ = junction to ambient thermal resistance

P_{tot} = (device) total power dissipation

An example of this calculation is show below:

Conditions:

$T_{amb} = 50$ °C

$R_{th(j-a)} = 33.9$ °C/W (per JEDEC 51 standard for multilayer PCB)

$I_{LED} = 30$ mA / channel

$I_{DD(max)} = 20$ mA

$V_{DD} = 5$ V

LEDs per channel = 5 LEDs / channel

LED $V_{F(typ)} = 3$ V per LED (15 V total for 5 LEDs in series)

LED V_F mismatch = 0.2 V per LED (1 V total for 5 LEDs in series)

$V_{reg(drv)} = 0.8$ V (This will be present only in the LED string with the highest LED forward voltage.)

$V_{sup} = LED V_{F(typ)} + LED V_F \text{ mismatch} + V_{reg(drv)} = 15 \text{ V} + 1 \text{ V} + 0.8 \text{ V} = 16.8 \text{ V}$

P_{tot} calculation:

$$P_{\text{tot}} = \text{IC_power} + \text{LED drivers_power};$$

$$\text{IC_power} = (I_{\text{DD}} \times V_{\text{DD}})$$

$$\text{IC_power} = (0.02 \text{ A} \times 5 \text{ V}) = 0.1 \text{ W}$$

$$\text{LED drivers_power} = [(24 - 1) \times (I_{\text{LED}}) \times (\text{LED } V_{\text{F}} \text{ mismatch} + V_{\text{reg(drv)}})] + (I_{\text{LED}} \times V_{\text{reg(drv)}})$$

$$\text{LED drivers_power} = [23 \times 0.03 \text{ A} \times (1 \text{ V} + 0.8 \text{ V})] + (0.03 \text{ A} \times 0.8 \text{ V}) = 1.266 \text{ W}$$

$$P_{\text{tot}} = 0.1 \text{ W} + 1.266 \text{ W} = 1.366 \text{ W}$$

T_j calculation:

$$T_{\text{j}} = T_{\text{amb}} + R_{\text{th(j-a)}} \times P_{\text{tot}}$$

$$T_{\text{j}} = 50 \text{ }^{\circ}\text{C} + (33.9 \text{ }^{\circ}\text{C/W} \times 1.366 \text{ W}) = 96.31 \text{ }^{\circ}\text{C}$$

This confirms that the junction temperature is below the minimum overtemperature threshold of 130 °C, which ensures the device will not go into thermal shutdown under these conditions.

It is important to mention that the value of the thermal resistance junction-to-ambient ($R_{\text{th(j-a)}}$) strongly depends in the PCB design. Therefore, the thermal pad of the device should be attached to a big enough PCB copper area to ensure proper thermal dissipation (similar to JEDEC 51 standard). Several thermal vias in the PCB thermal pad should be used as well to increase the effectiveness of the heat dissipation (for example, 15 thermal vias). The thermal vias should be distributed evenly in the PCB thermal pad.

Finally, it is important to point out that this calculation should be taken as a reference only and therefore evaluations should still be performed under the application environment and conditions to confirm proper system operation.

11. Limiting values

Table 20. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|-----------------------|--------------------------------|--------------------------|-----------------------|------|------|
| V _{DD} | supply voltage | | -0.5 | +6.0 | V |
| V _{I/O} | voltage on an input/output pin | | V _{SS} - 0.5 | 5.5 | V |
| V _{drv(LED)} | LED driver voltage | | V _{SS} - 0.5 | 20 | V |
| I _{O(LEDn)} | output current on pin LEDn | | - | 65 | mA |
| I _{SS} | ground supply current | | - | 2.5 | A |
| P _{tot} | total power dissipation | T _{amb} = 25 °C | - | 2.95 | W |
| | | T _{amb} = 85 °C | - | 1.18 | W |
| T _{stg} | storage temperature | | -65 | +150 | °C |
| T _{amb} | ambient temperature | operating | -40 | +85 | °C |
| T _j | junction temperature | | -40 | +125 | °C |

12. Thermal characteristics

Table 21. Thermal characteristics

| Symbol | Parameter | Conditions | Typ | Unit |
|----------------------|---|------------|--------------------------|------|
| R _{th(j-a)} | thermal resistance from junction to ambient | HTSSOP38 | [1] 33.9 | °C/W |

[1] Per JEDEC 51 standard for multilayer PCB and wind speed (nm/s) = 0.

13. Static characteristics

Table 22. Static characteristics

$V_{DD} = 3\text{ V to }5.5\text{ V}$; $V_{SS} = 0\text{ V}$; $T_{amb} = -40\text{ °C to }+85\text{ °C}$; unless otherwise specified.

| Symbol | Parameter | Conditions | Min | Typ ^[1] | Max | Unit |
|---|--|--|------------------|--------------------|---------------|---------------|
| Supply | | | | | | |
| V_{DD} | supply voltage | | 3 | - | 5.5 | V |
| I_{DD} | supply current | on pin V_{DD} ; operating mode; $f_{SCL} = 1\text{ MHz}$ | | | | |
| | | $R_{ext} = 2\text{ k}\Omega$; LED[23:0] = off; IREF _x = 00h | - | 11 | 12 | mA |
| | | $R_{ext} = 1\text{ k}\Omega$; LED[23:0] = off; IREF _x = 00h | - | 13 | 14 | mA |
| | | $R_{ext} = 2\text{ k}\Omega$; LED[23:0] = on; IREF _x = FFh | - | 15 | 19 | mA |
| | | $R_{ext} = 1\text{ k}\Omega$; LED[23:0] = on; IREF _x = FFh | - | 17 | 21 | mA |
| I_{stb} | standby current | on pin V_{DD} ; no load; $f_{SCL} = 0\text{ Hz}$; MODE1[4] = 1; $V_I = V_{DD}$ | | | | |
| | | $V_{DD} = 3.3\text{ V}$ | - | 100 | 600 | μA |
| | | $V_{DD} = 5.5\text{ V}$ | - | 100 | 700 | μA |
| V_{POR} | power-on reset voltage | no load; $V_I = V_{DD}$ or V_{SS} | - | 2 | - | V |
| V_{PDR} | power-down reset voltage | no load; $V_I = V_{DD}$ or V_{SS} | ^[2] - | 1 | - | V |
| Inputs USCL, USDA | | | | | | |
| V_{IL} | LOW-level input voltage | | -0.5 | - | +0.3 V_{DD} | V |
| V_{IH} | HIGH-level input voltage | | 0.7 V_{DD} | - | 5.5 | V |
| I_L | leakage current | $V_I = V_{DD}$ or V_{SS} | -1 | - | +1 | μA |
| C_i | input capacitance | $V_I = V_{SS}$ | - | 6 | 10 | pF |
| Current controlled outputs (LED[23:0]) | | | | | | |
| $I_{O(LEDn)}$ | output current on pin LED _n | $V_O = 0.8\text{ V}$; IREF _x = 80h; $R_{ext} = 1\text{ k}\Omega$ | 25 | - | 30 | mA |
| | | $V_O = 0.8\text{ V}$; IREF _x = FFh; $R_{ext} = 1\text{ k}\Omega$ | 50 | - | 60 | mA |
| ΔI_O | output current variation | $V_{DD} = 3.0\text{ V}$; $T_{amb} = 25\text{ °C}$; $V_O = 0.8\text{ V}$; IREF _x = 80h; $R_{ext} = 1\text{ k}\Omega$; guaranteed by design | | | | |
| | | between bits (different ICs, same channel) | ^[3] - | - | ±6 | % |
| | | between bits (2 channels, same IC) | ^[4] - | - | ±4 | % |
| $V_{reg(drv)}$ | driver regulation voltage | minimum regulation voltage; IREF _x = FFh; $R_{ext} = 1\text{ k}\Omega$ | 0.8 | 1 | 20 | V |
| $I_{L(off)}$ | off-state leakage current | $V_O = 20\text{ V}$ | - | - | 1 | μA |
| OE input, RESET input | | | | | | |
| V_{IL} | LOW-level input voltage | | -0.5 | - | +0.3 V_{DD} | V |
| V_{IH} | HIGH-level input voltage | | 0.7 V_{DD} | - | 5.5 | V |
| I_{LI} | input leakage current | | -1 | - | +1 | μA |
| C_i | input capacitance | | - | 3.7 | 5 | pF |

Table 22. Static characteristics ...continued

$V_{DD} = 3\text{ V to }5.5\text{ V}$; $V_{SS} = 0\text{ V}$; $T_{amb} = -40\text{ °C to }+85\text{ °C}$; unless otherwise specified.

| Symbol | Parameter | Conditions | Min | Typ ^[1] | Max | Unit |
|-------------------------------------|--|-------------------------|------|--------------------|------|------|
| Address inputs AD2, AD1, AD0 | | | | | | |
| V_I | input voltage | voltage on an input pin | -0.5 | - | +5.5 | V |
| I_{LI} | input leakage current | | -1 | - | +1 | μA |
| C_i | input capacitance | | - | 3.7 | 5 | pF |
| Overtemperature protection | | | | | | |
| $T_{th(otp)}$ | overtemperature protection threshold temperature | rising | 130 | - | 150 | °C |
| | | hysteresis | 15 | - | 30 | °C |

[1] Typical limits at $V_{DD} = 3.3\text{ V}$, $T_{amb} = 25\text{ °C}$.

[2] V_{DD} must be lowered to 0.8 V in order to reset part.

[3] Part-to-part mismatch is calculated:

$$\Delta\% = \left(\frac{\left(\frac{I_{O(LED0)} + I_{O(LED1)} + \dots + I_{O(LED22)} + I_{O(LED23)}}{24} - \text{ideal output current} \right)}{\text{ideal output current}} \right) \times 100$$

where 'ideal output current' = 28.68 mA ($R_{ext} = 1\text{ k}\Omega$, $I_{REFx} = 80\text{h}$).

[4] Channel-to-channel mismatch is calculated:

$$\Delta\% = \left(\frac{I_{O(LEDn)} \text{ (where } n = 0 \text{ to } 23)}{\left(\frac{I_{O(LED0)} + I_{O(LED1)} + \dots + I_{O(LED22)} + I_{O(LED23)}}{24} \right)} - 1 \right) \times 100$$

14. Dynamic characteristics

Table 23. Dynamic characteristics

All the timing limits are valid within the operating supply voltage and ambient temperature range; $V_{DD} = 3 V \pm 0.2 V$ and $5.5 V \pm 0.3 V$; $T_{amb} = -40\text{ }^{\circ}\text{C}$ to $+85\text{ }^{\circ}\text{C}$; and refer to V_{IL} and V_{IH} with an input voltage of V_{SS} to V_{DD} .

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|---------------------|---|------------|-------|-----|------|------|
| f _{USCL} | USCL clock frequency | | [1] 0 | - | 5000 | kHz |
| t _{BUF} | bus free time between a STOP and START condition | | 0.08 | - | - | μs |
| t _{HD;STA} | hold time (repeated) START condition | | 0.05 | - | - | μs |
| t _{SU;STA} | set-up time for a repeated START condition | | 0.05 | - | - | μs |
| t _{SU;STO} | set-up time for STOP condition | | 0.05 | - | - | μs |
| t _{HD;DAT} | data hold time | | 10 | - | - | ns |
| t _{VD;DAT} | data valid time | | [2] - | - | - | ns |
| t _{SU;DAT} | data set-up time | | 30 | - | - | ns |
| t _{LOW} | LOW period of the USCL clock | | 50 | - | - | ns |
| t _{HIGH} | HIGH period of the USCL clock | | 50 | - | - | ns |
| t _f | fall time of both USDA and USCL signals | | - | - | 50 | ns |
| t _r | rise time of both USDA and USCL signals | | - | - | 50 | ns |
| t _{SP} | pulse width of spikes that must be suppressed by the input filter | | - | - | 10 | ns |

[1] Minimum USCL clock frequency is limited by the bus time-out feature, which resets the serial bus interface if either USDA or USCL is held LOW for a minimum of 25 ms. Disable bus time-out feature for DC operation.

[2] t_{VD;DAT} is not applicable to the U^Fm I²C-bus slave device.

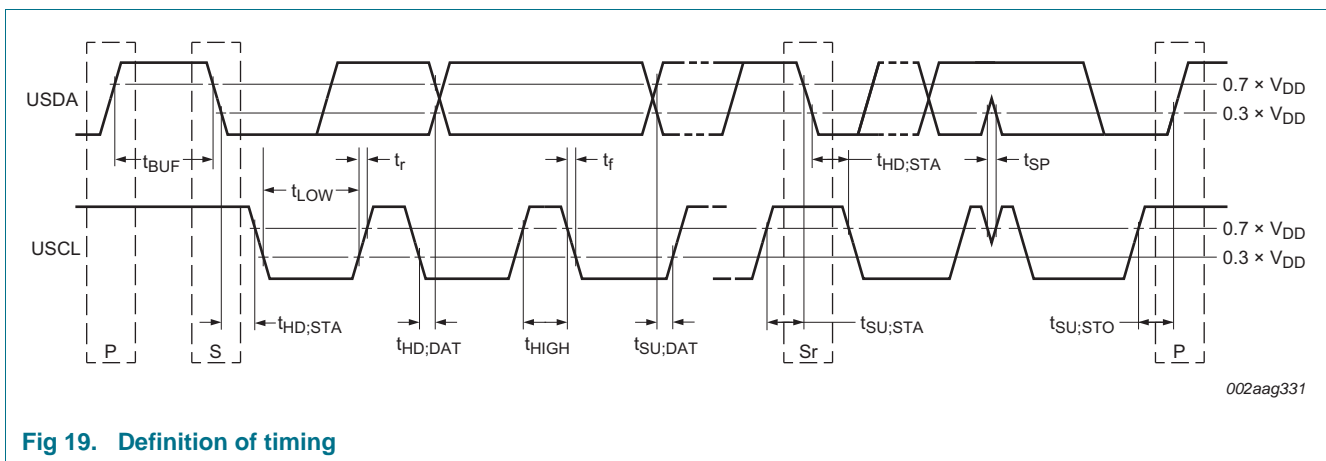
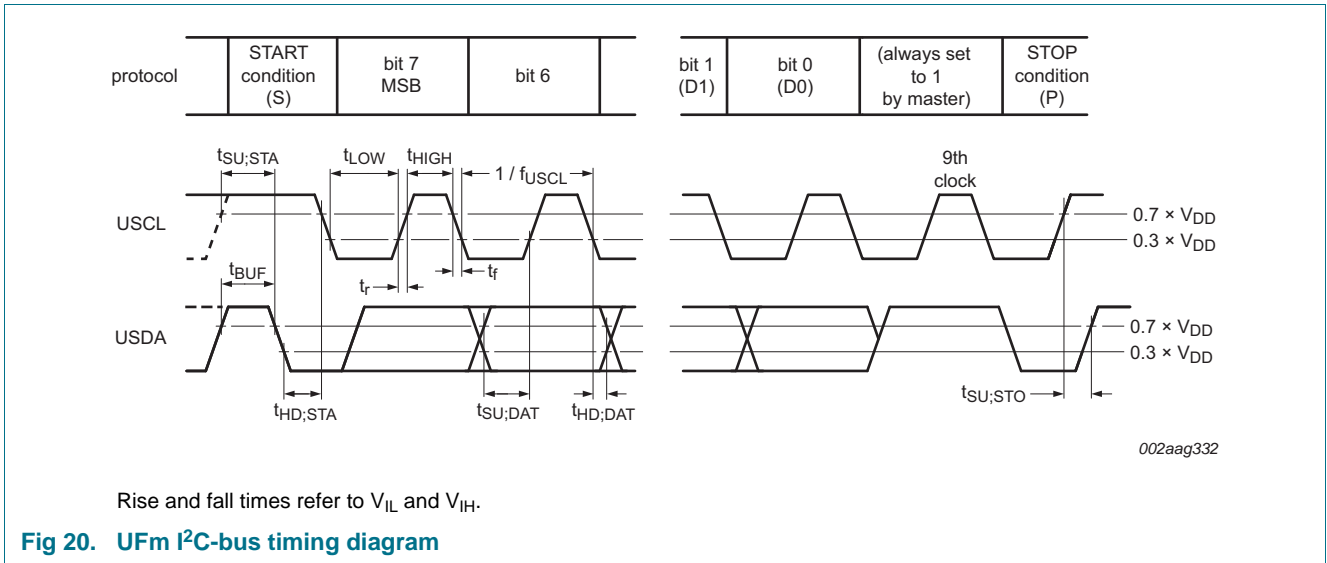
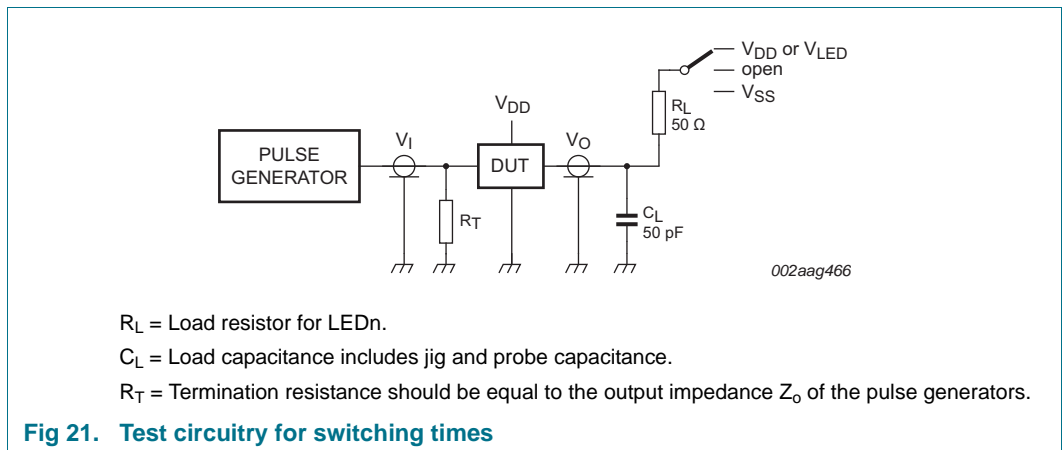


Fig 19. Definition of timing



15. Test information



16. Package outline

HTSSOP38: plastic thermal enhanced thin shrink small outline package; 38 leads; body with 4.4 mm; lead pitch 0.5 mm; exposed die pad

SOT1331-1

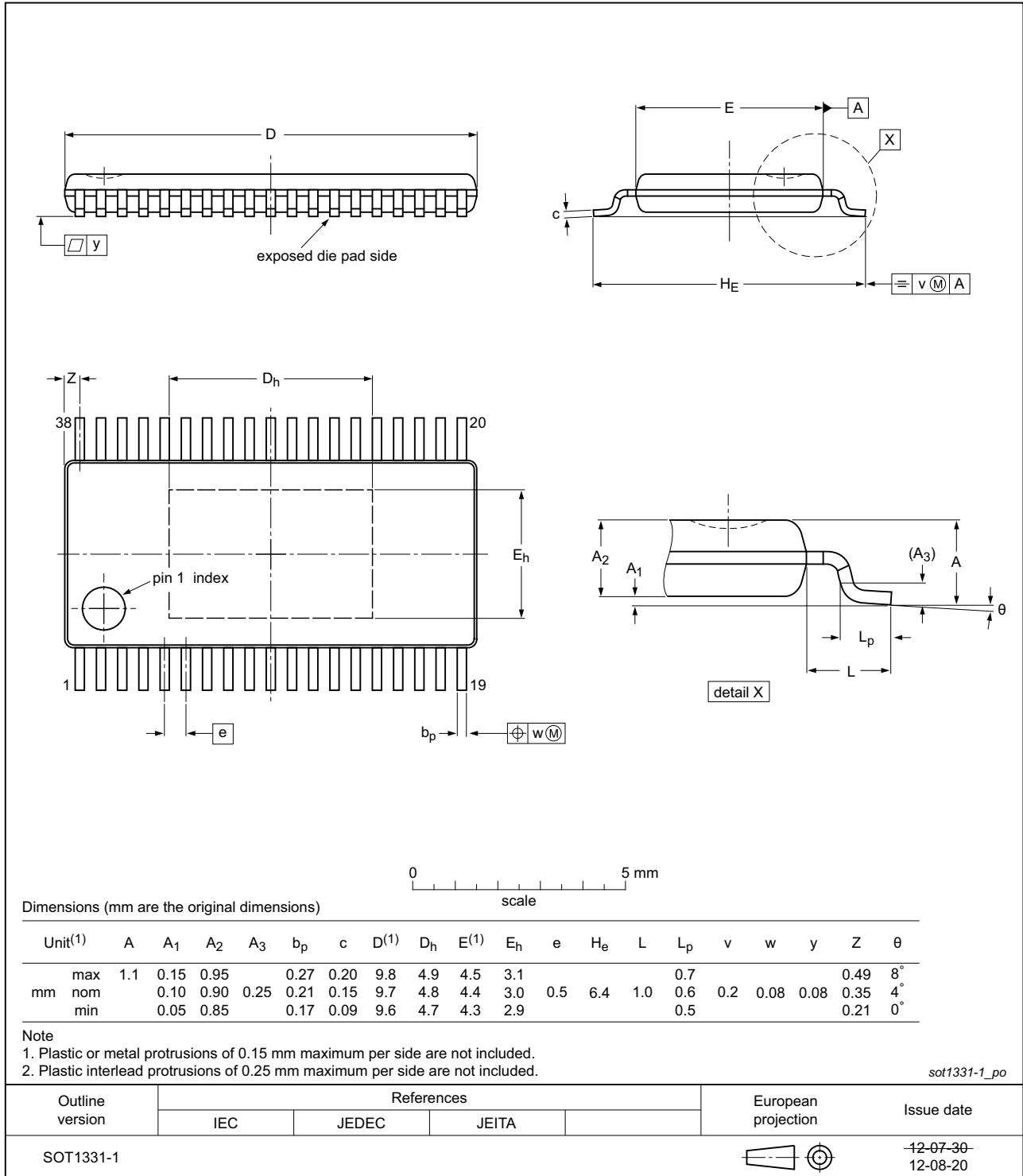


Fig 22. Package outline SOT1331-1 (HTSSOP38)

17. Handling information

All input and output pins are protected against ElectroStatic Discharge (ESD) under normal handling. When handling ensure that the appropriate precautions are taken as described in *JESD625-A* or equivalent standards.

18. Soldering of SMD packages

This text provides a very brief insight into a complex technology. A more in-depth account of soldering ICs can be found in Application Note *AN10365 "Surface mount reflow soldering description"*.

18.1 Introduction to soldering

Soldering is one of the most common methods through which packages are attached to Printed Circuit Boards (PCBs), to form electrical circuits. The soldered joint provides both the mechanical and the electrical connection. There is no single soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and Surface Mount Devices (SMDs) are mixed on one printed wiring board; however, it is not suitable for fine pitch SMDs. Reflow soldering is ideal for the small pitches and high densities that come with increased miniaturization.

18.2 Wave and reflow soldering

Wave soldering is a joining technology in which the joints are made by solder coming from a standing wave of liquid solder. The wave soldering process is suitable for the following:

- Through-hole components
- Leaded or leadless SMDs, which are glued to the surface of the printed circuit board

Not all SMDs can be wave soldered. Packages with solder balls, and some leadless packages which have solder lands underneath the body, cannot be wave soldered. Also, leaded SMDs with leads having a pitch smaller than ~0.6 mm cannot be wave soldered, due to an increased probability of bridging.

The reflow soldering process involves applying solder paste to a board, followed by component placement and exposure to a temperature profile. Leaded packages, packages with solder balls, and leadless packages are all reflow solderable.

Key characteristics in both wave and reflow soldering are:

- Board specifications, including the board finish, solder masks and vias
- Package footprints, including solder thieves and orientation
- The moisture sensitivity level of the packages
- Package placement
- Inspection and repair
- Lead-free soldering versus SnPb soldering

18.3 Wave soldering

Key characteristics in wave soldering are:

- Process issues, such as application of adhesive and flux, clinching of leads, board transport, the solder wave parameters, and the time during which components are exposed to the wave
- Solder bath specifications, including temperature and impurities

18.4 Reflow soldering

Key characteristics in reflow soldering are:

- Lead-free versus SnPb soldering; note that a lead-free reflow process usually leads to higher minimum peak temperatures (see [Figure 23](#)) than a SnPb process, thus reducing the process window
- Solder paste printing issues including smearing, release, and adjusting the process window for a mix of large and small components on one board
- Reflow temperature profile; this profile includes preheat, reflow (in which the board is heated to the peak temperature) and cooling down. It is imperative that the peak temperature is high enough for the solder to make reliable solder joints (a solder paste characteristic). In addition, the peak temperature must be low enough that the packages and/or boards are not damaged. The peak temperature of the package depends on package thickness and volume and is classified in accordance with [Table 24](#) and [25](#)

Table 24. SnPb eutectic process (from J-STD-020D)

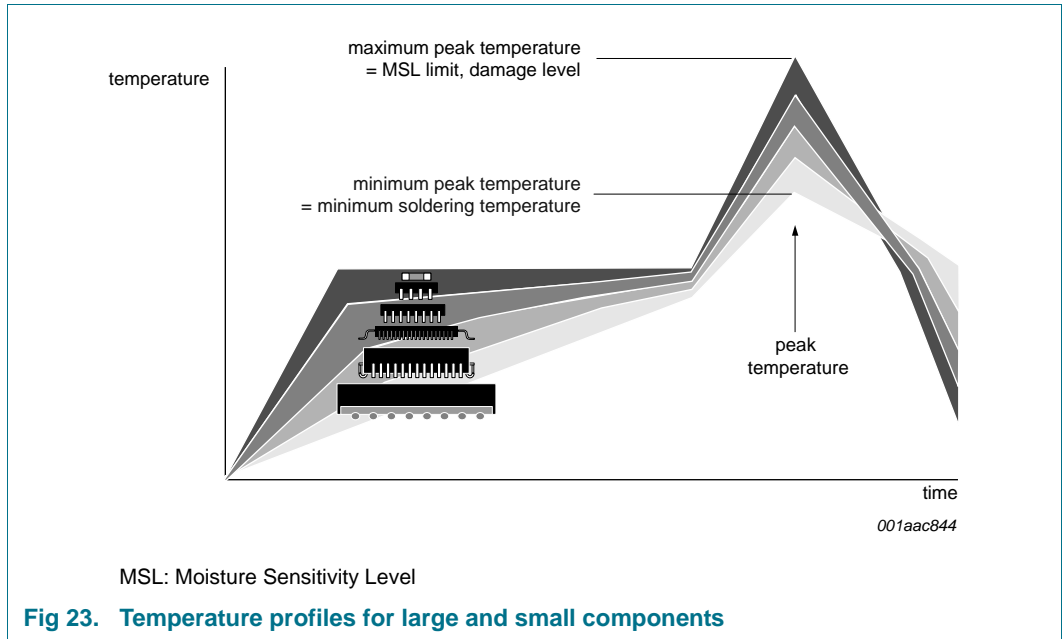
| Package thickness (mm) | Package reflow temperature (°C) | |
|------------------------|---------------------------------|-------|
| | Volume (mm ³) | |
| | < 350 | ≥ 350 |
| < 2.5 | 235 | 220 |
| ≥ 2.5 | 220 | 220 |

Table 25. Lead-free process (from J-STD-020D)

| Package thickness (mm) | Package reflow temperature (°C) | | |
|------------------------|---------------------------------|-------------|--------|
| | Volume (mm ³) | | |
| | < 350 | 350 to 2000 | > 2000 |
| < 1.6 | 260 | 260 | 260 |
| 1.6 to 2.5 | 260 | 250 | 245 |
| > 2.5 | 250 | 245 | 245 |

Moisture sensitivity precautions, as indicated on the packing, must be respected at all times.

Studies have shown that small packages reach higher temperatures during reflow soldering, see [Figure 23](#).

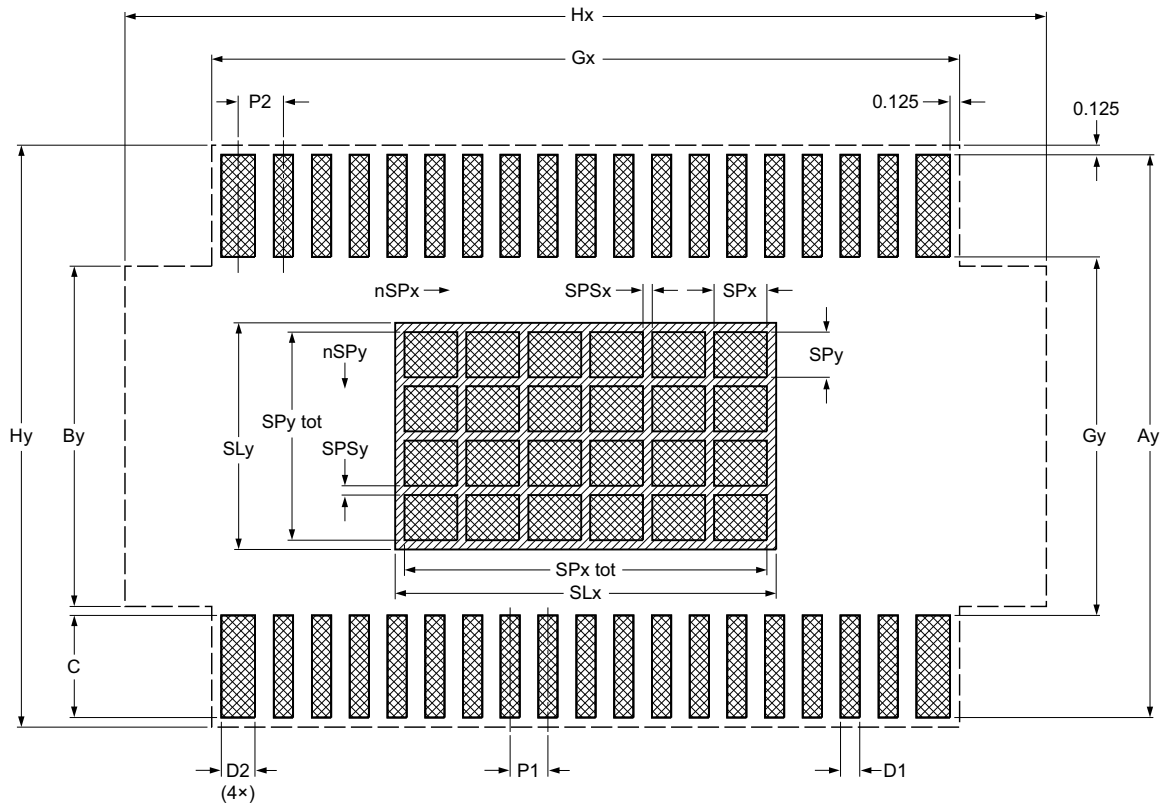


For further information on temperature profiles, refer to Application Note AN10365 “Surface mount reflow soldering description”.

19. Soldering: PCB footprints

Footprint information for reflow soldering of HTSSOP38 package

SOT1331-1



Generic footprint pattern
Refer to the package outline drawing for actual layout

solder land solder land plus solder paste

----- occupied area

| SPSx | SPSy | SPx tot | SPy tot |
|------|------|---------|---------|
| 0.12 | 0.12 | 4.8 | 2.76 |

Dimensions in mm

| P1 | P2 | Ay | By | C | D1 | D2 | Gx | Gy | Hx | Hy | nSPx | nSPy | SLx | SLy | SPx | SPy |
|-----|-----|------|-----|------|------|------|-----|------|------|-----|------|------|-------|-----|-----|-----|
| 0.5 | 0.6 | 7.45 | 4.5 | 1.35 | 0.25 | 0.45 | 9.9 | 4.75 | 12.2 | 7.7 | 6 | 4 | 5.040 | 3 | 0.7 | 0.6 |

Issue date ~~13-11-15~~
14-01-20

sot1331-1_fr

Fig 24. PCB footprint for SOT1331-1 (HTSSOP38); reflow soldering

20. Abbreviations

Table 26. Abbreviations

| Acronym | Description |
|----------------------|--|
| ACK | Acknowledge |
| DUT | Device Under Test |
| ESD | ElectroStatic Discharge |
| FET | Field-Effect Transistor |
| HBM | Human Body Model |
| I ² C-bus | Inter-Integrated Circuit bus |
| LED | Light Emitting Diode |
| LSB | Least Significant Bit |
| MSB | Most Significant Bit |
| NMOS | Negative-channel Metal-Oxide Semiconductor |
| PCB | Printed-Circuit Board |
| PMOS | Positive-channel Metal-Oxide Semiconductor |
| PWM | Pulse Width Modulation |
| RGB | Red/Green/Blue |
| RGBA | Red/Green/Blue/Amber |
| SMBus | System Management Bus |

21. Revision history

Table 27. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|--------------|--------------|--------------------|---------------|------------|
| PCU9956A v.1 | 20140124 | Product data sheet | - | - |

22. Legal information

22.1 Data sheet status

| Document status ^{[1][2]} | Product status ^[3] | Definition |
|-----------------------------------|-------------------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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